

## FEATURES

**IQ modulator with integrated fractional-N PLL**

**RF output frequency range: 1550 MHz to 2650 MHz**

**Internal LO frequency range: 2100 MHz to 2600 MHz**

**Output P1dB: 14.2 dBm @ 2140 MHz**

**Output IP3: 33.2 dBm @ 2140 MHz**

**Noise floor: -159.6 dBm/Hz @ 2140 MHz**

**Baseband bandwidth: 750 MHz (3 dB)**

**SPI serial interface for PLL programming**

**Integrated LDOs and LO buffer**

**Power supply: 5 V/240 mA**

**40-lead 6 mm × 6 mm LFCSP**

## APPLICATIONS

**Cellular communications systems**

**GSM/EDGE, CDMA2000, W-CDMA, TD-SCDMA, LTE**

**Broadband wireless access systems**

**Satellite modems**

## GENERAL DESCRIPTION

The ADRF6703 provides a quadrature modulator and synthesizer solution within a small 6 mm × 6 mm footprint while requiring minimal external components.

The ADRF6703 is designed for RF outputs from 1550 MHz to 2650 MHz. The low phase noise VCO and high performance quadrature modulator make the ADRF6703 suitable for next generation communication systems requiring high signal dynamic range and linearity. The integration of the IQ modulator, PLL, and VCO provides for significant board savings and reduces the BOM and design complexity.

The integrated fractional-N PLL/synthesizer generates a  $2 \times f_{LO}$  input to the IQ modulator. The phase detector together with an external loop filter is used to control the VCO output. The VCO output is applied to a quadrature divider. To reduce spurious components, a sigma-delta ( $\Sigma-\Delta$ ) modulator controls the programmable PLL divider.

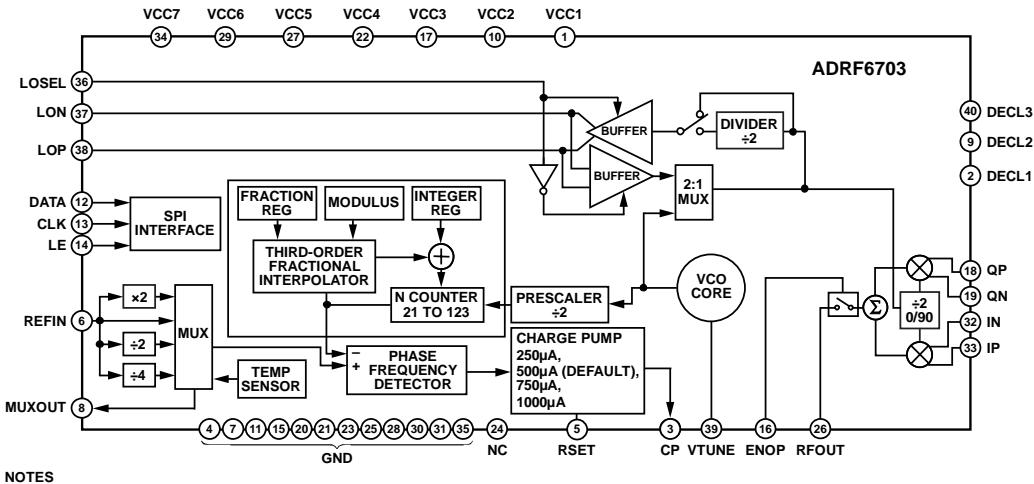
The IQ modulator has wideband differential I and Q inputs, which support baseband as well as complex IF architectures. The single-ended modulator output is designed to drive a  $50 \Omega$  load impedance and can be disabled.

The ADRF6703 is fabricated using an advanced silicon-germanium BiCMOS process. It is available in a 40-lead, exposed-paddle, Pb-free, 6 mm × 6 mm LFCSP package. Performance is specified from -40°C to +85°C. A lead-free evaluation board is available.

**Table 1.**

Part No.	Internal LO Range	$\pm 3$ dB RF <sub>OUT</sub> Balun Range
ADRF6701	750 MHz	400 MHz
	1150 MHz	1250 MHz
ADRF6702	1550 MHz	1200 MHz
	2150 MHz	2400 MHz
ADRF6703	2100 MHz	1550 MHz
	2600 MHz	2650 MHz
ADRF6704	2500 MHz	2050 MHz
	290 MHz	3000 MHz

## FUNCTIONAL BLOCK DIAGRAM



*Figure 1.*

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**Rev. B**

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## REVISION HISTORY

### 10/11—Rev. A to Rev. B

Changes to Table 1..... 1

### 6/11—Rev. 0 to Rev. A

Changes to Figure 1 .....

1

Changes to Figure 5..... 10

Changes to Figure 17 and Figure 18..... 12

### 6/11—Revision 0: Initial Version

## SPECIFICATIONS

$V_S = 5 \text{ V}$ ;  $T_A = 25^\circ\text{C}$ ; baseband I/Q amplitude = 1 V p-p differential sine waves in quadrature with a 500 mV dc bias; baseband I/Q frequency ( $f_{BB}$ ) = 1 MHz;  $f_{PFD} = 38.4 \text{ MHz}$ ;  $f_{REF} = 153.6 \text{ MHz}$  at +4 dBm Re:50  $\Omega$  (1 V p-p); 130 kHz loop filter, unless otherwise noted.

Table 2.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
OPERATING FREQUENCY RANGE	IQ modulator ( $\pm 3 \text{ dB}$ RF output range) PLL LO range	1550 2100	2650 2600	MHz MHz	
RF OUTPUT = 2140 MHz	RFOUT pin Baseband VIQ = 1 V p-p differential RF output divided by baseband input voltage	4.95 0.95 14.2 −44.1 −52.3 +0.0/−0.6 0.04 −63.0 −52.0 70.1 33.2 −159.6		dBm dB dBm dBm dBc Degrees dB dBc dBc dBm dBm dBm	
Nominal Output Power	$P_{OUT} = P(f_{LO} \pm (2 \times f_{BB}))$				
IQ Modulator Voltage Gain	$P_{OUT} = P(f_{LO} \pm (3 \times f_{BB}))$				
OP1dB	$f_{1BB} = 3.5 \text{ MHz}$ , $f_{2BB} = 4.5 \text{ MHz}$ , $P_{OUT} \approx -2 \text{ dBm}$ per tone				
Carrier Feedthrough	$f_{1BB} = 3.5 \text{ MHz}$ , $f_{2BB} = 4.5 \text{ MHz}$ , $P_{OUT} \approx -2 \text{ dBm}$ per tone				
Sideband Suppression	I/Q inputs = 0 V differential with 500 mV dc bias, 20 MHz carrier offset				
Quadrature Error					
I/Q Amplitude Balance					
Second Harmonic					
Third Harmonic					
Output IP2					
Output IP3					
Noise Floor					
RF OUTPUT = 2300 MHz	RFOUT pin Baseband VIQ = 1 V p-p differential RF output divided by baseband input voltage	4.48 0.48 13.5 −46.0 −44.0 −0.25/−0.98 0.06 −67.0 −53.0 68.6 32.7 −159.7		dBm dB dBm dBm dBc Degrees dB dBc dBc dBm dBm dBm	
Nominal Output Power	$P_{OUT} = P(f_{LO} \pm (2 \times f_{BB}))$				
IQ Modulator Voltage Gain	$P_{OUT} = P(f_{LO} \pm (3 \times f_{BB}))$				
OP1dB	$f_{1BB} = 3.5 \text{ MHz}$ , $f_{2BB} = 4.5 \text{ MHz}$ , $P_{OUT} \approx -2 \text{ dBm}$ per tone				
Carrier Feedthrough	$f_{1BB} = 3.5 \text{ MHz}$ , $f_{2BB} = 4.5 \text{ MHz}$ , $P_{OUT} \approx -2 \text{ dBm}$ per tone				
Sideband Suppression	I/Q inputs = 0 V differential with 500 mV dc bias, 20 MHz carrier offset				
Quadrature Error					
I/Q Amplitude Balance					
Second Harmonic					
Third Harmonic					
Output IP2					
Output IP3					
Noise Floor					
RF OUTPUT = 2600 MHz	RFOUT pin Baseband VIQ = 1 V p-p differential RF output divided by baseband input voltage	2.75 −1.25 11.8 −46.8 −35.3 0.56/2.3 0.06 −63.0 −51.0 62.0 29.2 −161.7		dBm dB dBm dBm dBc Degrees dB dBc dBc dBm dBm dBm	
Nominal Output Power	$P_{OUT} = P(f_{LO} \pm (2 \times f_{BB}))$				
IQ Modulator Voltage Gain	$P_{OUT} = P(f_{LO} \pm (3 \times f_{BB}))$				
OP1dB	$f_{1BB} = 3.5 \text{ MHz}$ , $f_{2BB} = 4.5 \text{ MHz}$ , $P_{OUT} \approx -2 \text{ dBm}$ per tone				
Carrier Feedthrough	$f_{1BB} = 3.5 \text{ MHz}$ , $f_{2BB} = 4.5 \text{ MHz}$ , $P_{OUT} \approx -2 \text{ dBm}$ per tone				
Sideband Suppression	I/Q inputs = 0 V differential with 500 mV dc bias, 20 MHz carrier offset				
Quadrature Error					
I/Q Amplitude Balance					
Second Harmonic					
Third Harmonic					
Output IP2					
Output IP3					
Noise Floor					
SYNTHESIZER SPECIFICATIONS	Synthesizer specifications referenced to the modulator output	2100	2600	MHz	
Internal LO Range					
Figure of Merit (FOM) <sup>1</sup>		−222.0		dBc/Hz/Hz	

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
REFERENCE CHARACTERISTICS					
REFIN Input Frequency	REFIN, MUXOUT pins	12	4	160	MHz
REFIN Input Capacitance		20		40	pF
Phase Detector Frequency				0.25	MHz
MUXOUT Output Level	Low (lock detect output selected) High (lock detect output selected)	2.7	50	V	V
MUXOUT Duty Cycle				%	
CHARGE PUMP					
Charge Pump Current	Programmable to 250 $\mu$ A, 500 $\mu$ A, 750 $\mu$ A, 1000 $\mu$ A	1	500	2.8	$\mu$ A
Output Compliance Range				V	
PHASE NOISE (FREQUENCY = 2140 MHz, $f_{PFD} = 38.4$ MHz)	Closed loop operation (see Figure 35 for loop filter design)				
	10 kHz offset		-105.3		dBc/Hz
	100 kHz offset		-103.1		dBc/Hz
	1 MHz offset		-127.9		dBc/Hz
	10 MHz offset		-149.7		dBc/Hz
Integrated Phase Noise	1 kHz to 10 MHz integration bandwidth		0.29		$^{\circ}$ rms
Reference Spurs	$f_{PFD}/2$		-110		dBc
	$f_{PFD}$		-102.0		dBc
	$f_{PFD} \times 2$		-87.2		dBc
	$f_{PFD} \times 3$		-90.4		dBc
	$f_{PFD} \times 4$		-98.4		dBc
PHASE NOISE (FREQUENCY = 2300 MHz, $f_{PFD} = 38.4$ MHz)	Closed loop operation (see Figure 35 for loop filter design)				
	10 kHz offset		-103.5		dBc/Hz
	100 kHz offset		-102.2		dBc/Hz
	1 MHz offset		-128.4		dBc/Hz
	10 MHz offset		-149.5		dBc/Hz
Integrated Phase Noise	1 kHz to 10 MHz integration bandwidth		0.295		$^{\circ}$ rms
Reference Spurs	$f_{PFD}/2$		-110.7		dBc
	$f_{PFD}$		-102.3		dBc
	$f_{PFD} \times 2$		-85.5		dBc
	$f_{PFD} \times 3$		-92.4		dBc
	$f_{PFD} \times 4$		-101.1		dBc
PHASE NOISE (FREQUENCY = 2600 MHz, $f_{PFD} = 38.4$ MHz)	Closed loop operation (see Figure 35 for loop filter design)				
	10 kHz offset		-98.8		dBc/Hz
	100 kHz offset		-100.2		dBc/Hz
	1 MHz offset		-129.2		dBc/Hz
	10 MHz offset		-151.0		dBc/Hz
Integrated Phase Noise	1 kHz to 10 MHz integration bandwidth		0.37		$^{\circ}$ rms
Reference Spurs	$f_{PFD}/2$		-110.6		dBc
	$f_{PFD}$		-106.5		dBc
	$f_{PFD} \times 2$		-88.6		dBc
	$f_{PFD} \times 3$		-92.4		dBc
	$f_{PFD} \times 4$		-102.5		dBc
RF OUTPUT HARMONICS	Measured at RFOUT, frequency = 2140 MHz				
	Second harmonic		-41		dBc
	Third harmonic		-65		dBc
LO INPUT/OUTPUT	LOP, LON				
Output Frequency Range	Divide by 2 circuit in LO path enabled	2100		2600	MHz
	Divide by 2 circuit in LO path disabled	4200		5200	MHz
LO Output Level at 2140 MHz	2x LO or 1x LO mode, into a 50 $\Omega$ load, LO buffer enabled		0.1		dBm
LO Input Level	Externally applied 2x LO, PLL disabled		0		dBm
LO Input Impedance	Externally applied 2x LO, PLL disabled		50		$\Omega$

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
BASEBAND INPUTS	IP, IN, QP, QN pins				
I and Q Input DC Bias Level		400	500	600	mV
Bandwidth	P <sub>OUT</sub> ≈ -7 dBm, RF flatness of IQ modulator output calibrated out 0.5 dB 3 dB		350		MHz
Differential Input Impedance	Frequency = 1 MHz <sup>2</sup>		750		MHz
Differential Input Capacitance	Frequency = 1 MHz <sup>2</sup>		945		Ω
			1		pF
LOGIC INPUTS	CLK, DATA, LE, ENOP, LOSEL				
Input High Voltage, V <sub>INH</sub>		1.4		3.3	V
Input Low Voltage, V <sub>INL</sub>		0		0.7	V
Input Current, I <sub>INH</sub> /I <sub>INL</sub>			0.1		μA
Input Capacitance, C <sub>IN</sub>			5		pF
TEMPERATURE SENSOR	VPTAT voltage measured at MUXOUT				
Output Voltage	T <sub>A</sub> = 25°C, RL ≥ 10 kΩ (LO buffer disabled)		1.624		V
Temperature Coefficient	T <sub>A</sub> = -40°C to +85°C, RL ≥ 10 kΩ		3.65		mV/°C
POWER SUPPLIES	VCC1, VCC2, VCC3, VCC4, VCC5, VCC6, VCC7				
Voltage Range	Normal Tx mode (PLL and IQMOD enabled, LO buffer disabled)	4.75	5	5.25	V
Supply Current	Tx mode using external LO input (internal VCO/PLL disabled)		240		mA
	Tx mode with LO buffer enabled		134		mA
	Power-down mode		290		mA
			22		μA

<sup>1</sup> The figure of merit (FOM) is computed as phase noise (dBc/Hz) – 10log10(f<sub>PFD</sub>) – 20log10(f<sub>LO</sub>/f<sub>PFD</sub>). The FOM was measured across the full LO range, with f<sub>REF</sub> = 80 MHz, f<sub>REF</sub> power = 10 dBm (500 V/μs slew rate) with a 40 MHz f<sub>PFD</sub>. The FOM was computed at 50 kHz offset.

<sup>2</sup> Refer to Figure 40 for plot of input impedance over frequency.

## TIMING CHARACTERISTICS

Table 3.

Parameter	Limit	Unit	Test Conditions/Comments
t <sub>1</sub>	20	ns min	LE to CLK setup time
t <sub>2</sub>	10	ns min	DATA to CLK setup time
t <sub>3</sub>	10	ns min	DATA to CLK hold time
t <sub>4</sub>	25	ns min	CLK high duration
t <sub>5</sub>	25	ns min	CLK low duration
t <sub>6</sub>	10	ns min	CLK to LE setup time
t <sub>7</sub>	20	ns min	LE pulse width

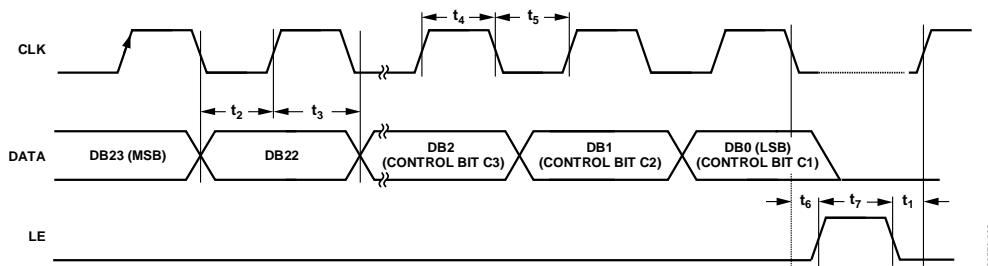


Figure 2. Timing Diagram

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## ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
Supply Voltage (VCC1 to VCC7)	5.5 V
Digital I/O, CLK, DATA, LE	–0.3 V to +3.6 V
LOP, LON	18 dBm
IP, IN, QP, QN	–0.5 V to +1.5 V
REFIN	–0.3 V to +3.6 V
$\theta_{JA}$ (Exposed Paddle Soldered Down) <sup>1</sup>	35°C/W
Maximum Junction Temperature	150°C
Operating Temperature Range	–40°C to +85°C
Storage Temperature Range	–65°C to +150°C

<sup>1</sup> Per JDEC standard JESD 51-2.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

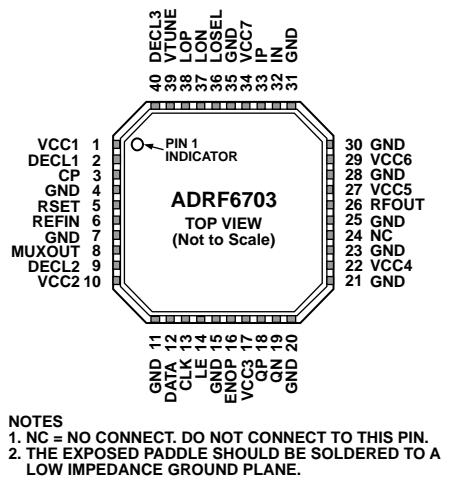


Figure 3. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
1, 10, 17, 22, 27, 29, 34	VCC1, VCC2, VCC3, VCC4, VCC5, VCC6, VCC7	Power Supply Pins. The power supply voltage range is 4.75 V to 5.25 V. Drive all of these pins from the same power supply voltage. Decouple each pin with 100 pF and 0.1 µF capacitors located close to the pin.
2	DECL1	Decoupling Node for Internal 3.3 V LDO. Decouple this pin with 100 pF and 0.1 µF capacitors located close to the pin.
3	CP	Charge Pump Output Pin. Connect VTUNE to this pin through the loop filter. If an external VCO is being used, connect the output of the loop filter to the VCO's voltage control pin. The PLL control loop should then be closed by routing the VCO's frequency output back into the ADRF6703 through the LON and LOP pins.
4, 7, 11, 15, 20, 21, 23, 25, 28, 30, 31, 35	GND	Ground. Connect these pins to a low impedance ground plane.
24	NC	Do not connect to this pin.
5	RSET	Charge Pump Current. The nominal charge pump current can be set to 250 µA, 500 µA, 750 µA, or 1000 µA using DB10 and DB11 of Register 4 and by setting DB18 to 0 (CP reference source). In this mode, no external RSET is required. If DB18 is set to 1, the four nominal charge pump currents ( $I_{NOMINAL}$ ) can be externally tweaked according to the following equation:
		$R_{SET} = \left( \frac{217.4 \times I_{CP}}{I_{NOMINAL}} \right) - 37.8\Omega$ where $I_{CP}$ is the base charge pump current in microamps. For further details on the charge pump current, see the Register 4—PLL Charge Pump, PFD, and Reference Path Control section.
6	REFIN	Reference Input. The nominal input level is 1 V p-p. Input range is 12 MHz to 160 MHz. This pin has high input impedance and should be ac-coupled. If REFIN is being driven by laboratory test equipment, the pin should be externally terminated with a 50 Ω resistor (place the ac-coupling capacitor between the pin and the resistor). When driven from an 50 Ω RF signal generator, the recommended input level is 4 dBm.
8	MUXOUT	Multiplexer Output. This output allows a digital lock detect signal, a voltage proportional to absolute temperature (VPTAT), or a buffered, frequency-scaled reference signal to be accessed externally. The output is selected by programming DB21 to DB23 in Register 4.
9	DECL2	Decoupling Node for 2.5 V LDO. Connect 100 pF, 0.1 µF, and 10 µF capacitors between this pin and ground.
12	DATA	Serial Data Input. The serial data input is loaded MSB first with the three LSBs being the control bits.

Pin No.	Mnemonic	Description
13	CLK	Serial Clock Input. This serial clock input is used to clock in the serial data to the registers. The data is latched into the 24-bit shift register on the CLK rising edge. Maximum clock frequency is 20 MHz.
14	LE	Latch Enable. When the LE input pin goes high, the data stored in the shift registers is loaded into one of the six registers, the relevant latch being selected by the first three control bits of the 24-bit word.
16	ENOP	Modulator Output Enable/Disable. See Table 6.
18, 19, 32, 33	QP, QN, IN, IP	Modulator Baseband Inputs. Differential in-phase and quadrature baseband inputs. These inputs should be dc-biased to 0.5 V.
26	RFOUT	RF Output. Single-ended, 50 Ω internally biased RF output. RFOUT must be ac-coupled to its load.
36	LOSEL	LO Select. This digital input pin determines whether the LOP and LON pins operate as inputs or outputs. This pin should not be left floating. LOP and LON become inputs if the LOSEL pin is set low and the LDRV bit of Register 5 is set low. External LO drive must be a 2× LO. In addition to setting LOSEL and LDRV low and providing an external 2× LO, the LXL bit of Register 5 (DB4) must be set to 1 to direct the external LO to the IQ modulator. LON and LOP become outputs when LOSEL is high or if the LDRV bit of Register 5 (DB3) is set to 1. A 1× LO or 2× LO output can be selected by setting the LDIV bit of Register 5 (DB5) to 1 or 0 respectively (see Table 7).
37, 38	LON, LOP	Local Oscillator Input/Output. The internally generated 1× LO or 2× LO is available on these pins. When internal LO generation is disabled, an external 1× LO or 2× LO can be applied to these pins.
39	VTUNE	VCO Control Voltage Input. This pin is driven by the output of the loop filter. Nominal input voltage range on this pin is 1.3 V to 2.5 V. If the external VCO mode is activated, this pin can be left open.
40	DECL3	Decoupling Node for VCO LDO. Connect a 100 pF capacitor and a 10 μF capacitor between this pin and ground.
	EP	Exposed Paddle. The exposed paddle should be soldered to a low impedance ground plane.

Table 6. Enabling RFOUT

ENOP	Register 5 Bit DB6	RFOUT
X <sup>1</sup>	0	Disabled
0	X <sup>1</sup>	Disabled
1	1	Enabled

<sup>1</sup> X = don't care.Table 7. LO Port Configuration<sup>1, 2</sup>

LON/LOP Function	LOSEL	Register 5 Bit DB5(LDIV)	Register 5 Bit DB4(LXL)	Register 5 Bit DB3 (LDRV)
Input (2× LO)	0	X	1	0
Output (Disabled)	0	X	0	0
Output (1× LO)	0	0	0	1
Output (1× LO)	1	0	0	0
Output (1× LO)	1	0	0	1
Output (2× LO)	0	1	0	1
Output (2× LO)	1	1	0	0
Output (2× LO)	1	1	0	1

<sup>1</sup> X = don't care.<sup>2</sup> LOSEL should not be left floating.

## TYPICAL PERFORMANCE CHARACTERISTICS

$V_S = 5$  V;  $T_A = 25^\circ\text{C}$ ; baseband I/Q amplitude = 1 V p-p differential sine waves in quadrature with a 500 mV dc bias; baseband I/Q frequency ( $f_{BB}$ ) = 1 MHz;  $f_{PFD} = 38.4$  MHz;  $f_{REF} = 153.6$  MHz at +4 dBm Re:50  $\Omega$  (1 V p-p); 130 kHz loop filter, unless otherwise noted.

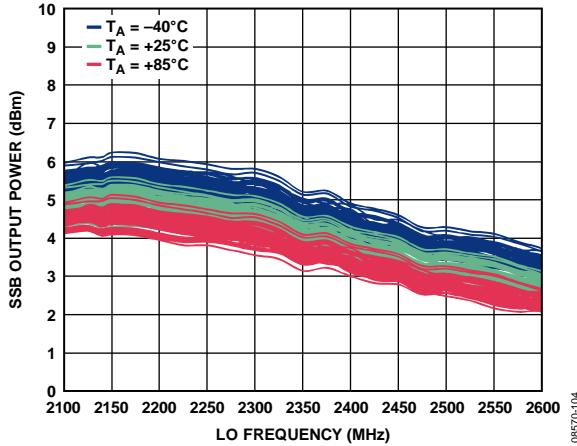


Figure 4. Single Sideband (SSB) Output Power ( $P_{OUT}$ ) vs. LO Frequency ( $f_{LO}$ ) and Temperature; Multiple Devices Shown

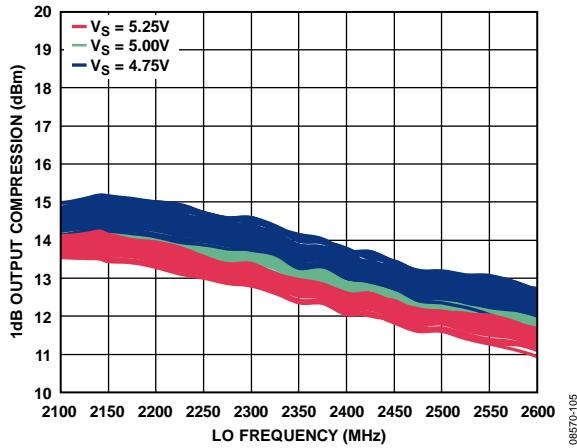


Figure 5. SSB Output 1dB Compression Point ( $OP_{1dB}$ ) vs. LO Frequency ( $f_{LO}$ ) and Temperature; Multiple Devices Shown

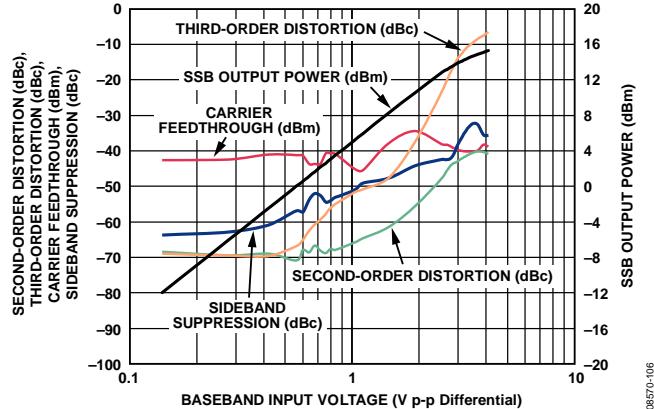


Figure 6. SSB Output Power, Second- and Third-Order Distortion, Carrier Feedthrough and Sideband Suppression vs. Baseband Differential Input Voltage ( $f_{OUT} = 2140$  MHz)

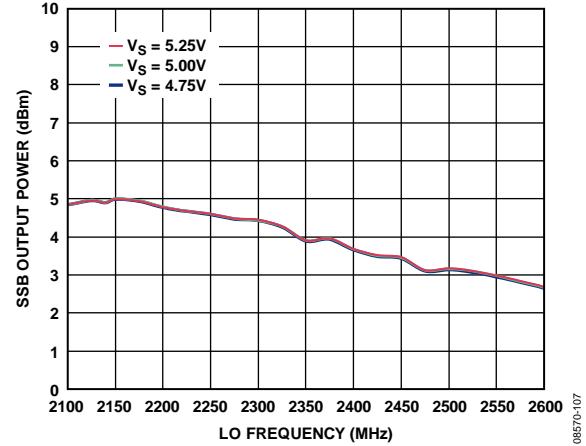


Figure 7. Single Sideband (SSB) Output Power ( $P_{OUT}$ ) vs. LO Frequency ( $f_{LO}$ ) and Power Supply; Multiple Devices Shown

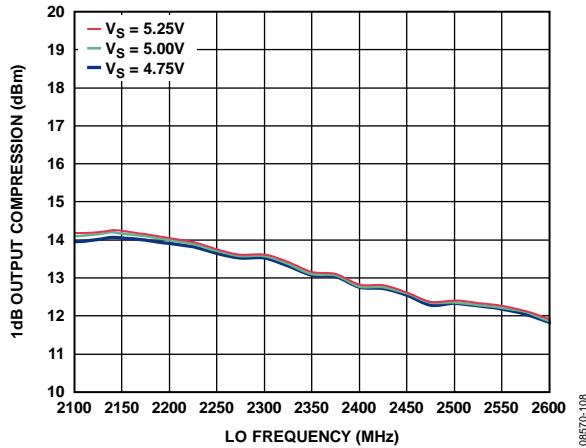


Figure 8. SSB Output 1dB Compression Point ( $OP_{1dB}$ ) vs. LO Frequency ( $f_{LO}$ ) and Power Supply

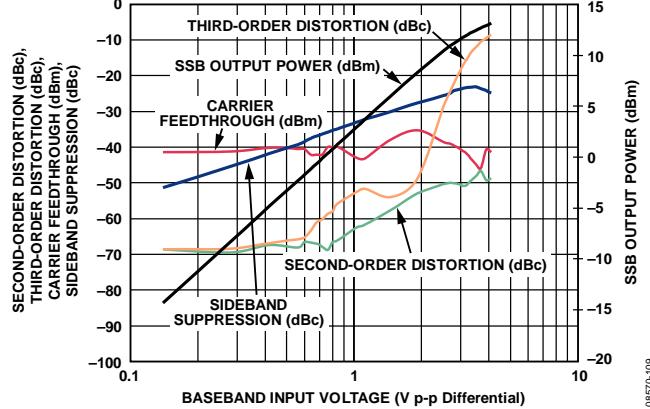
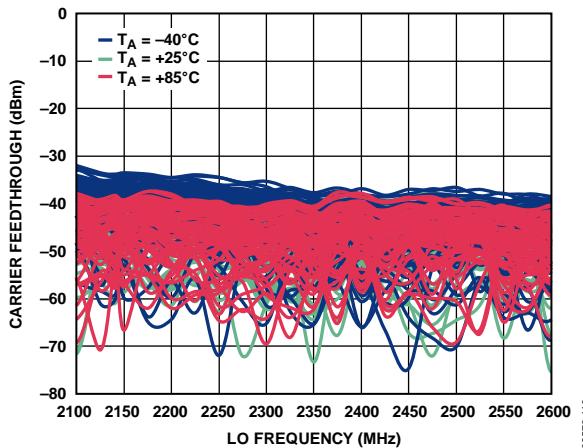
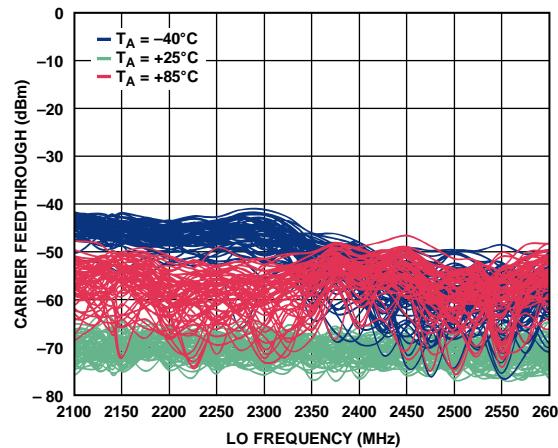


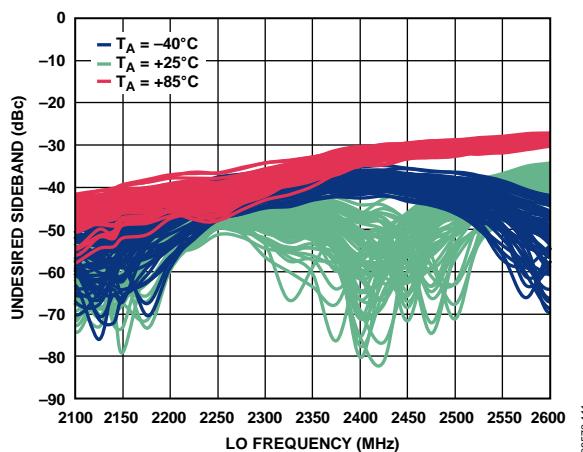
Figure 9. SSB Output Power, Second- and Third-Order Distortion, Carrier Feedthrough and Sideband Suppression vs. Baseband Differential Input Voltage ( $f_{OUT} = 2600$  MHz)



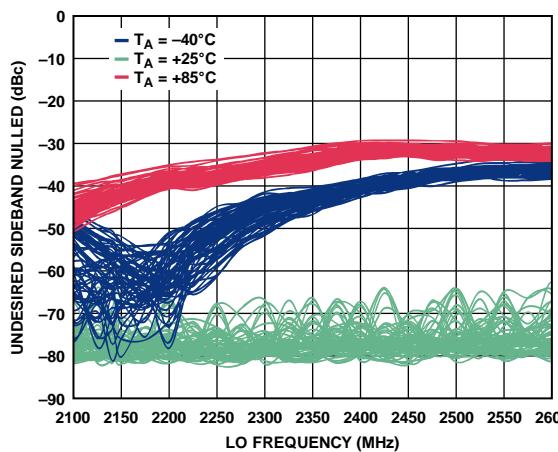
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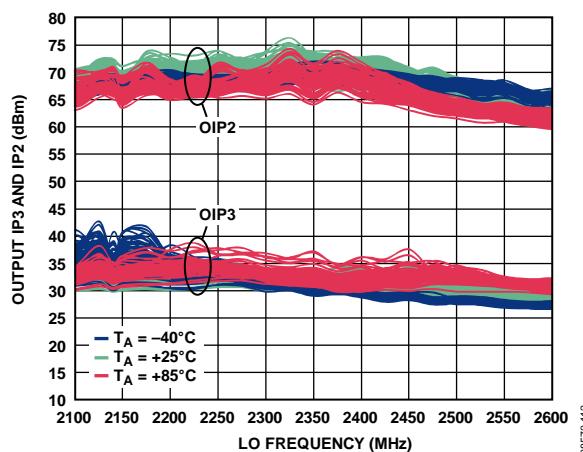
08570-113



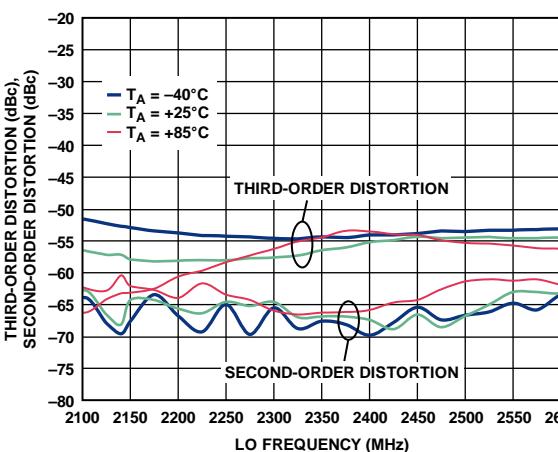
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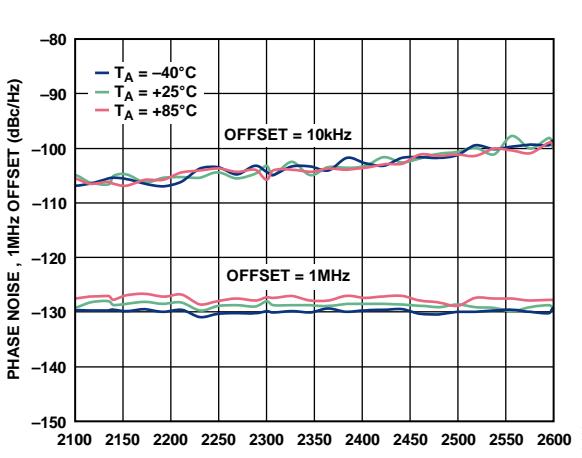
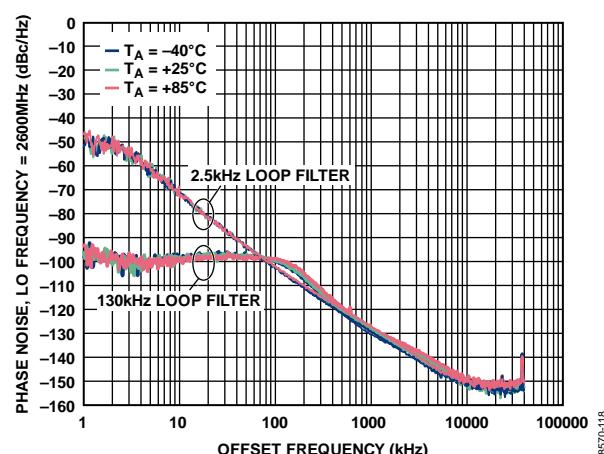
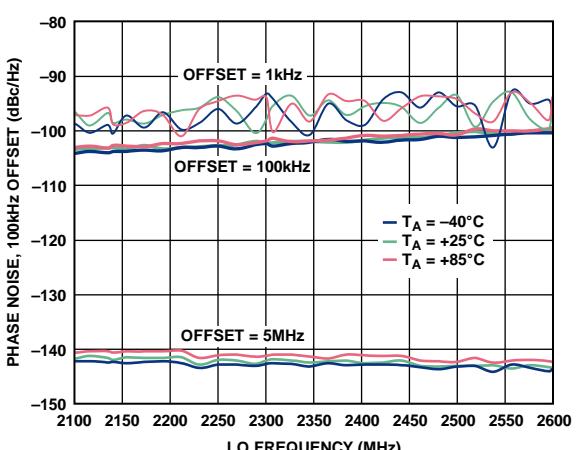
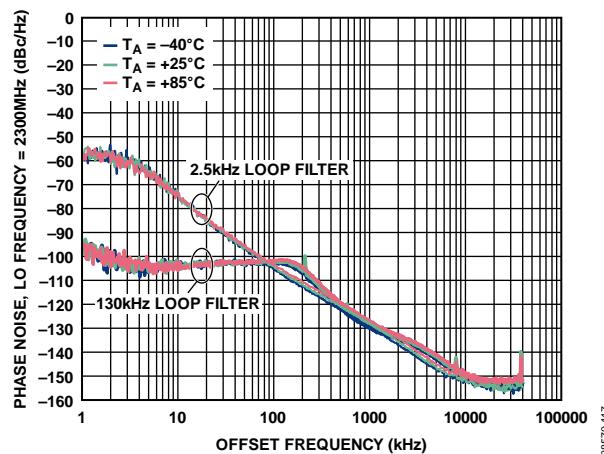
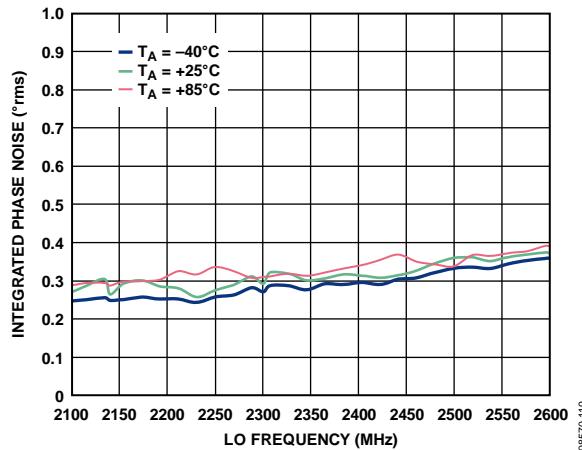
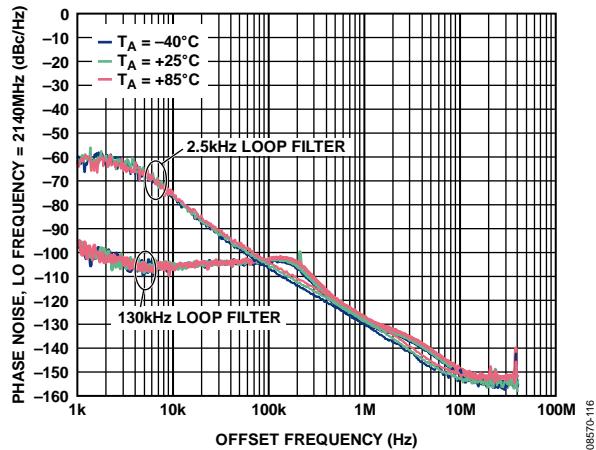
08570-114



08570-112



08570-115



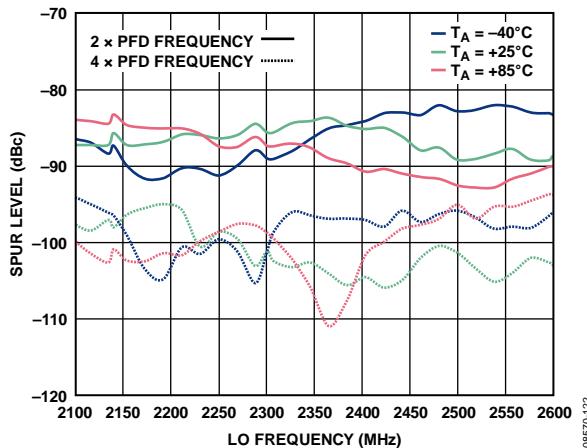


Figure 22. PLL Reference Spurs vs. LO Frequency (2x PFD and 4x PFD) at Modulator Output

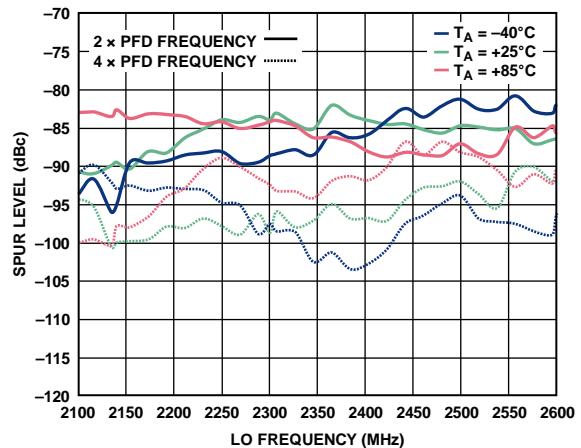


Figure 25. PLL Reference Spurs vs. LO Frequency (2x PFD and 4x PFD) at LO Output

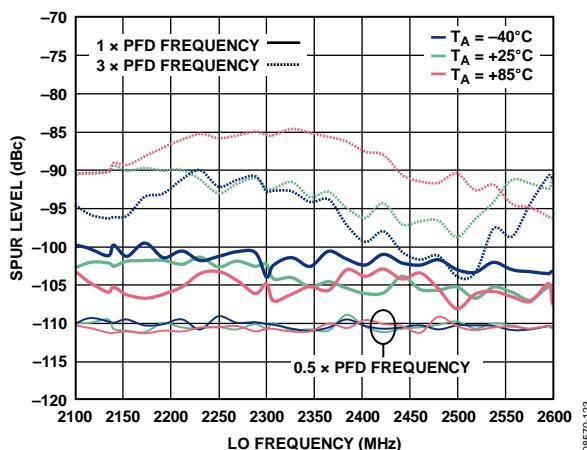


Figure 23. PLL Reference Spurs vs. LO Frequency (0.5x PFD, 1x PFD, and 3x PFD) at Modulator Output

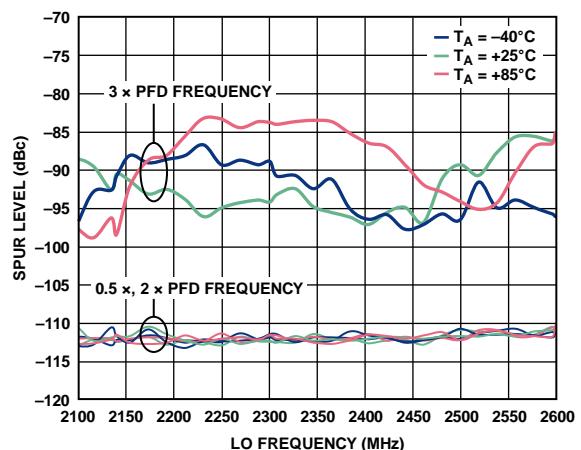


Figure 26. PLL Reference Spurs vs. LO Frequency (0.5x PFD, 2x PFD, and 3x PFD) at LO Output

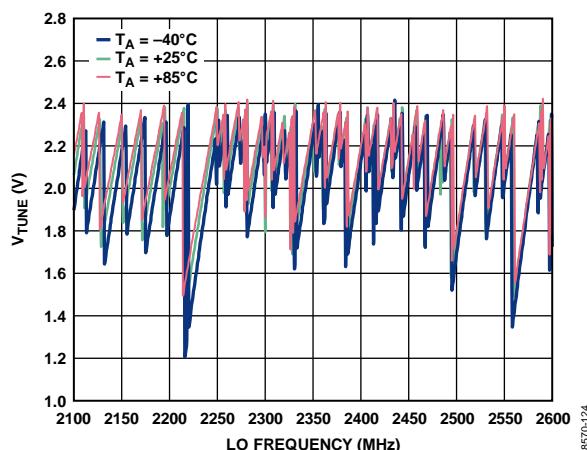


Figure 24. VTUNE vs. LO Frequency and Temperature

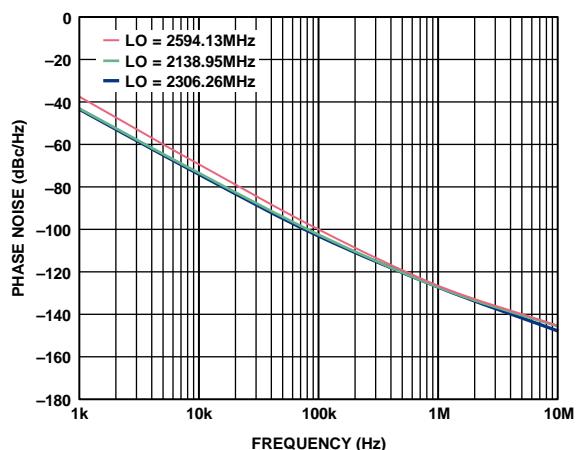
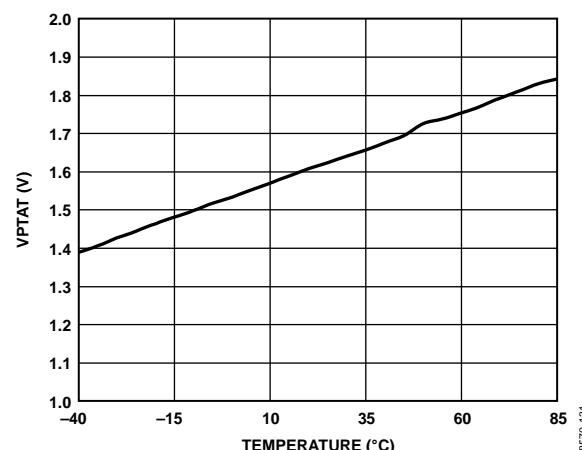
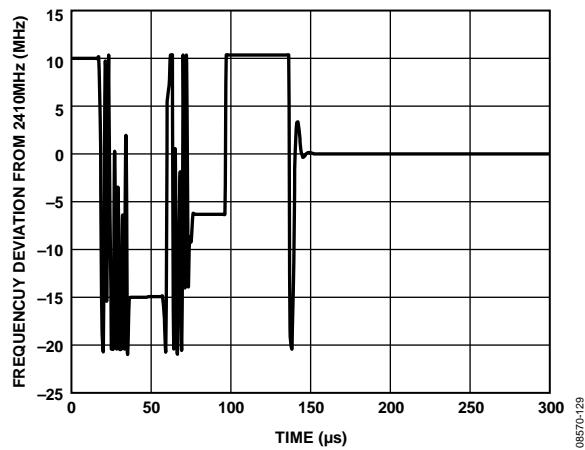
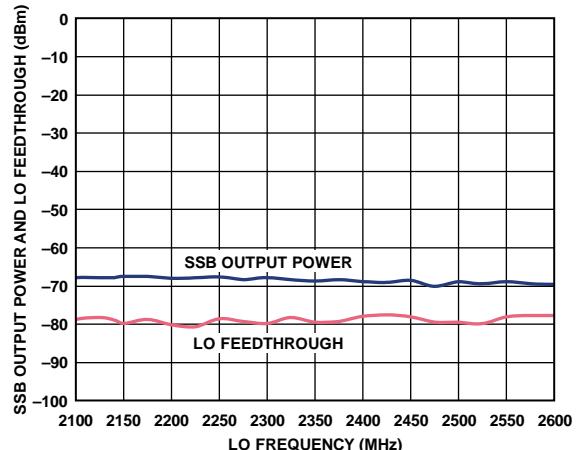
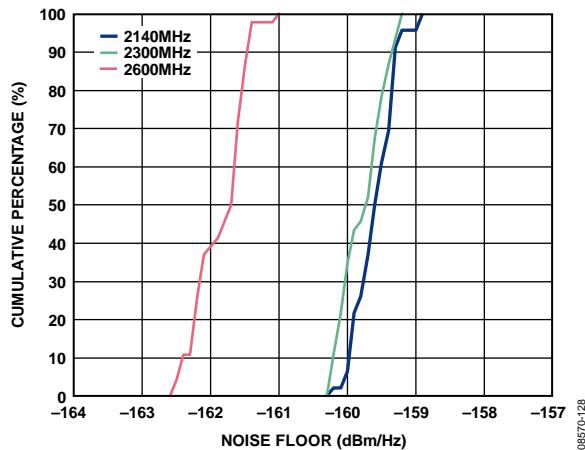


Figure 27. Open-Loop VCO Phase Noise at 2138.95 MHz, 2306.26 MHz, and 2594.13 MHz



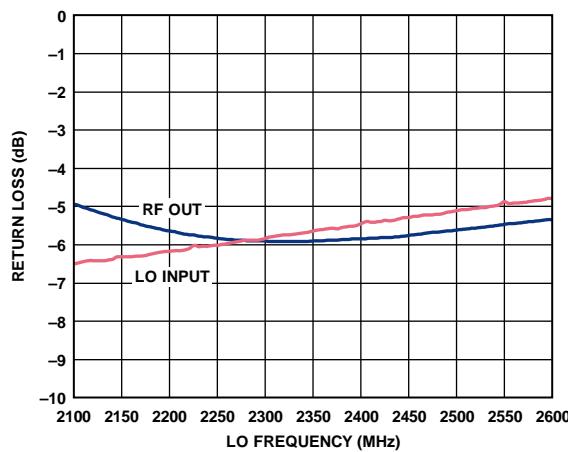


Figure 32. Input Return Loss of LO Input (LON, LOP Driven Through MABA-007159 1:1 Balun) and Output Return Loss of RFOUT vs. Frequency

08570-132

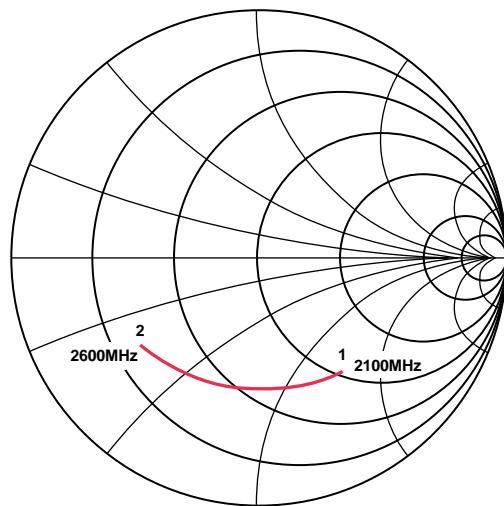


Figure 34. Smith Chart Representation of RF Output

08570-134

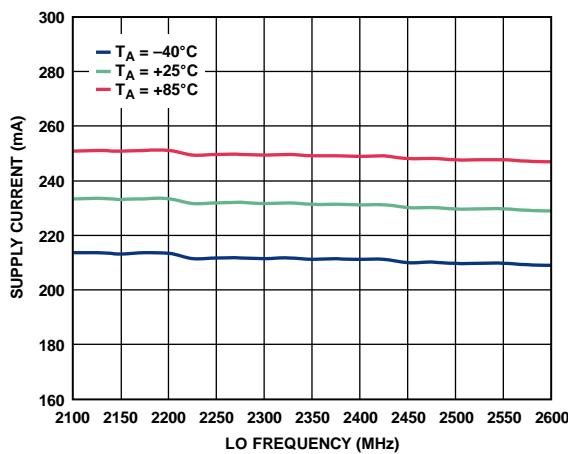


Figure 33. Power Supply Current vs. Frequency and Temperature (PLL and IQMOD Enabled, LO Buffer Disabled)

08570-133

## THEORY OF OPERATION

The [ADRF6703](#) integrates a high performance IQ modulator with a state of the art fractional-N PLL. The [ADRF6703](#) also integrates a low noise VCO. The programmable SPI port allows the user to control the fractional-N PLL functions and the modulator optimization functions. This includes the capability to operate with an externally applied LO or VCO.

The quadrature modulator core within the [ADRF6703](#) is a part of the next generation of industry-leading modulators from Analog Devices, Inc. The baseband inputs are converted to currents and then mixed to RF using high performance NPN transistors. The mixer output currents are transformed to a single-ended RF output using an integrated RF transformer balun. The high performance active mixer core, coupled with the low-loss RF transformer balun results in an exceptional OIP3 and OP1dB, with a very low output noise floor for excellent dynamic range. The use of a passive transformer balun rather than an active output stage leads to an improvement in OIP3 with no sacrifice in noise floor. At 2140 MHz the [ADRF6703](#) typically provides an output P1dB of 14.2 dBm, OIP3 of 33.2 dBm, and an output noise floor of  $-159.6 \text{ dBm/Hz}$ . Typical image rejection under these conditions is  $-52.3 \text{ dBc}$  with no additional I and Q gain compensation.

### PLL + VCO

The fractional divide function of the PLL allows the frequency multiplication value from REFIN to the LOP/LON outputs to be a fractional value rather than restricted to an integer as in traditional PLLs. In operation, this multiplication value is INT + (FRAC/MOD) where INT is the integer value, FRAC is the fractional value, and MOD is the modulus value, all of which are programmable via the SPI port. In previous fractional-N PLL designs, the fractional multiplication was achieved by periodically changing the fractional value in a deterministic way. The downside of this was often spurious components close to the fundamental signal. In the [ADRF6703](#), a sigma delta modulator is used to distribute the fractional value randomly, thus significantly reducing the spurious content due to the fractional function.

### BASIC CONNECTIONS FOR OPERATION

Figure 35 shows the basic connections for operating the [ADRF6703](#) as they are implemented on the device's evaluation board. The seven power supply pins should be individually decoupled using 100 pF and 0.1  $\mu\text{F}$  capacitors located as close as possible to the pins. A single 10  $\mu\text{F}$  capacitor is also recommended. The three internal decoupling nodes (labeled DECL3, DECL2, and DECL1) should be individually decoupled with capacitors as shown in Figure 35.

The four I and Q inputs should be driven with a bias level of 500 mV. These inputs are generally dc-coupled to the outputs of a dual DAC (see the DAC-to-IQ Modulator Interfacing and IQ Filtering sections for more information).

A 1 V p-p (0.353 V rms) differential sine wave on the I and Q inputs results in a single sideband output power of 4.95 dBm (at 2140 MHz) at the RFOUT pin (this pin should be ac-coupled as shown in Figure 35). This corresponds to an IQ modulator voltage gain of 0.95 dB.

The reference frequency for the PLL (typically 1 V p-p between 12 MHz and 160 MHz) should be applied to the REFIN pin, which should be ac-coupled. If the REFIN pin is being driven from a  $50 \Omega$  source (for example, a lab signal generator), the pin should be terminated with  $50 \Omega$  as shown in Figure 35 (an RF drive level of +4 dBm should be applied). Multiples or fractions of the REFIN signal can be brought back off-chip at the multiplexer output pin (MUXOUT). A lock-detect signal and an analog voltage proportional to the ambient temperature can also be brought out on this pin by setting the appropriate bits on (DB21-DB23) in Register 4 (see the Register Description section).

### EXTERNAL LO

The internally generated local oscillator (LO) signal can be brought off-chip as either a  $1\times$  LO or a  $2\times$  LO (via pins LOP and LON) by asserting the LOSEL pin and making the appropriate internal register settings. The LO output must be disabled whenever the RF output of the IQ modulator is disabled.

The LOP and LON pins can also be used to apply an external LO. This can be used to bypass the internal PLL/VCO or if operation using an external VCO is desired. To turn off the PLL Register 6, Bits[20:17] must be zero.

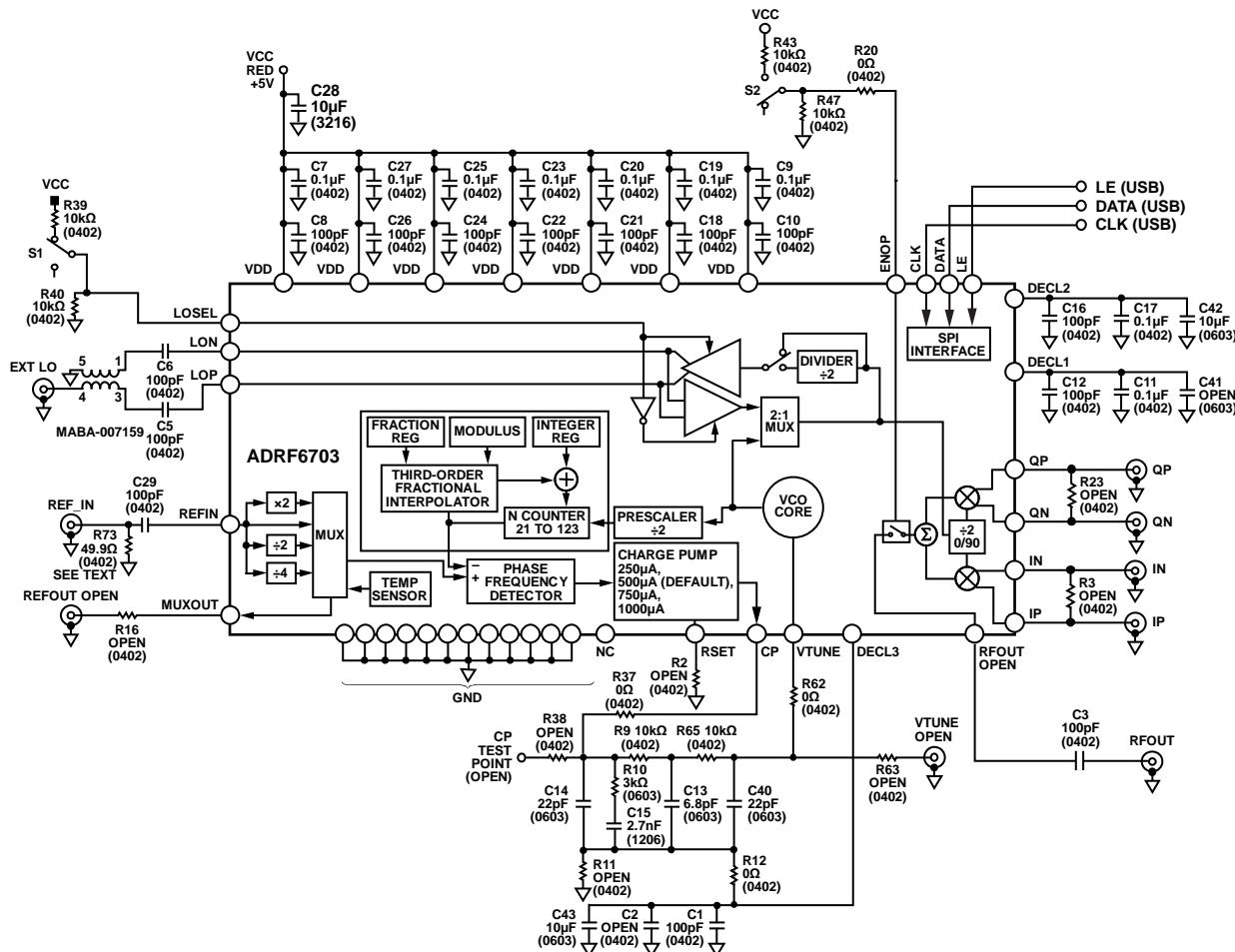


Figure 35. Basic Connections for Operation (Loop Filter Set to 130 kHz)

08570-023

## LOOP FILTER

The loop filter is connected between the CP and VTUNE pins. The return for the loop filter components should be to Pin 40 (DECL3). The loop filter design in Figure 35 results in a 3 dB loop bandwidth of 130 kHz. The ADRF6703 closed loop phase noise was also characterized using a 2.5 kHz loop filter design. The recommended components for both filter designs are shown in Table 8. For assistance in designing loop filters with other characteristics, download the most recent revision of ADIsimPLL™ from [www.analog.com/adisimpll](http://www.analog.com/adisimpll). Operation with an external VCO is possible. In this case, the return for the loop filter components is ground (assuming a ground reference on the external VCO tuning input). The output of the loop filter is connected to the external VCO's tuning pin. The output of the VCO is brought back into the device on the LOP and LON pins (using a balun if necessary).

Table 8. Recommended Loop Filter Components

Component	130 kHz Loop Filter	2.5 kHz Loop Filter
C14	22 pF	0.1 μF
R10	3 kΩ	68 Ω
C15	2.7 nF	4.7 μF
R9	10 kΩ	270 Ω
C13	6.8 pF	47 nF
R65	10 kΩ	0 Ω
C40	22 pF	Open
R37	0 Ω	0 Ω
R11	Open	Open
R12	0 Ω	0 Ω

## DAC-TO-IQ MODULATOR INTERFACING

The [ADRF6703](#) is designed to interface with minimal components to members of the Analog Devices, Inc., family of TxDACs®. These dual-channel differential current output DACs provide an output current swing from 0 mA to 20 mA. The interface described in this section can be used with any DAC that has a similar output.

An example of an interface using the [AD9122](#) TxDAC is shown in Figure 36. The baseband inputs of the [ADRF6703](#) require a dc bias of 500 mV. The average output current on each of the outputs of the [AD9122](#) is 10 mA. Therefore, a single 50 Ω resistor to ground from each of the DAC outputs results in an average current of 10 mA flowing through each of the resistors, thus producing the desired 500 mV dc bias for the inputs to the [ADRF6703](#).

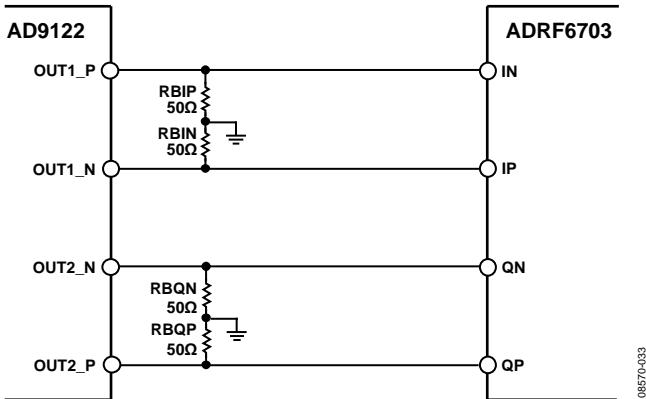


Figure 36. Interface Between the AD9122 and [ADRF6703](#) with 50 Ω Resistors to Ground to Establish the 500 mV DC Bias for the [ADRF6703](#) Baseband Inputs

The [AD9122](#) output currents have a swing that ranges from 0 mA to 20 mA. With the 50 Ω resistors in place, the ac voltage swing going into the [ADRF6703](#) baseband inputs ranges from 0 V to 1 V (with the DAC running at 0 dBFS). So the resulting drive signal from each differential pair is 2 V p-p differential with a 500 mV dc bias.

## ADDING A SWING-LIMITING RESISTOR

The voltage swing for a given DAC output current can be reduced by adding a third resistor to the interface. This resistor is placed in the shunt across each differential pair, as shown in Figure 37. It has the effect of reducing the ac swing without changing the dc bias already established by the 50 Ω resistors.

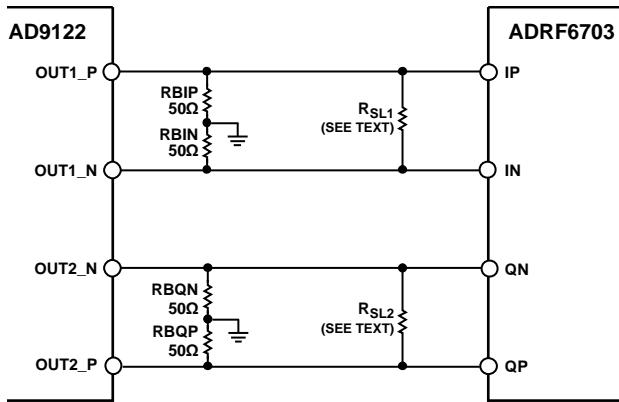


Figure 37. AC Voltage Swing Reduction Through the Introduction of a Shunt Resistor Between the Differential Pair

08570-034

The value of this ac voltage swing limiting resistor ( $R_{SL}$  as shown in Figure 37) is chosen based on the desired ac voltage swing and IQ modulator output power. Figure 38 shows the relationship between the swing-limiting resistor and the peak-to-peak ac swing that it produces when 50 Ω bias-setting resistors are used. A higher value of swing-limiting resistor will increase the output power of the [ADRF6703](#) and signal-to-noise ratio (SNR) at the cost if higher intermodulation distortion. For most applications, the optimum value for this resistor will be between 100 Ω and 300 Ω.

When setting the size of the swing-limiting resistor, the input impedance of the I and Q inputs should be taken into account. The I and Q inputs have a differential input resistance of 920 Ω. As a result, the effective value of the swing-limiting resistance is 920 Ω in parallel with the chosen swing-limiting resistor. For example, if a swing-limiting resistance of 200 Ω is desired (based on Figure 37), the value of  $R_{SL}$  should be set such that

$$200 \Omega = (920 \times R_{SL}) / (920 + R_{SL})$$

resulting in a value for  $R_{SL}$  of 255 Ω.

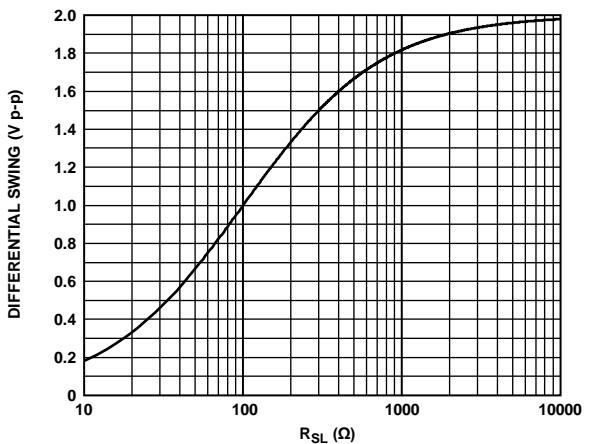


Figure 38. Relationship Between the AC Swing-Limiting Resistor and the Peak-to-Peak Voltage Swing with 50 Ω Bias-Setting Resistors

08570-235

## IQ FILTERING

An antialiasing filter must be placed between the DAC and modulator to filter out Nyquist images and broadband DAC noise. The interface for setting up the biasing and ac swing discussed in the Adding a Swing-Limiting Resistor section, lends itself well to the introduction of such a filter. The filter can be inserted between the dc bias setting resistors and the ac swing-limiting resistor. Doing so establishes the input and output impedances for the filter.

Unless a swing-limiting resistor of  $100\ \Omega$  is chosen, the filter must be designed to support different source and load impedances. In addition, the differential input capacitance of the I and Q inputs ( $1\text{ pF}$ ) should be factored into the filter design. Modern filter design tools allow for the simulation and design of filters with differing source and load impedances as well as inclusion of reactive load components.

## BASEBAND BANDWIDTH

Figure 39 shows the frequency response of the ADRF6703's baseband inputs. This plot shows 0.5 dB and 3 dB bandwidths of 350 MHz and 750 MHz respectively. Any flatness variations across frequency at the ADRF6703 RF output have been calibrated out of this measurement.

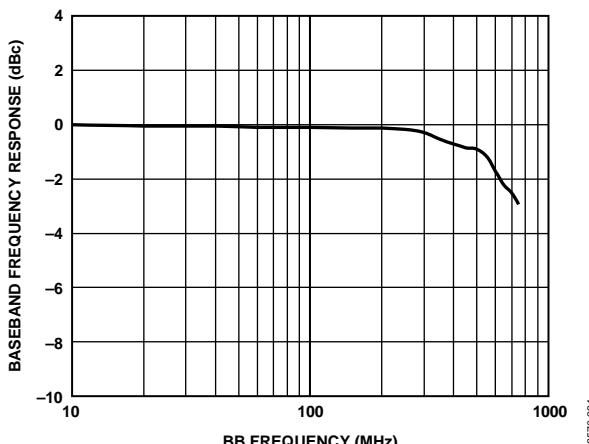


Figure 39. Baseband Bandwidth

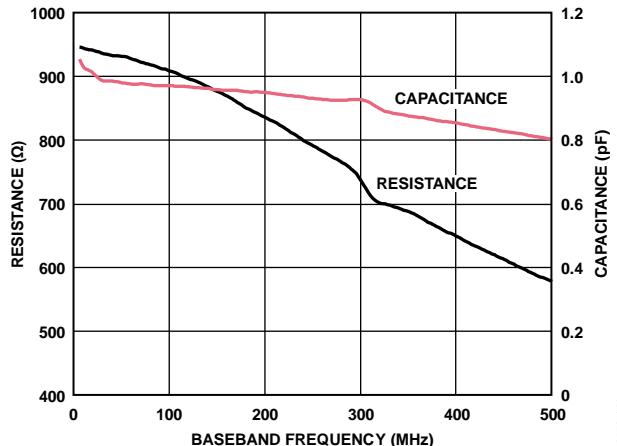


Figure 40. Differential Baseband Input R and Input C Equivalents (Shunt R, Shunt C)

## DEVICE PROGRAMMING AND REGISTER SEQUENCING

The device is programmed via a 3-pin SPI port. The timing requirements for the SPI port are shown in Table 3 and Figure 2.

Eight programmable registers, each with 24 bits, control the operation of the device. The register functions are listed in Table 9. The eight registers should initially be programmed in reverse order, starting with Register 7 and finishing with Register 0. Once all eight registers have been initially programmed, any of the registers can be updated without any attention to sequencing.

Software is available on the ADRF6703 product page at [www.analog.com](http://www.analog.com) that allows programming of the evaluation board from a PC running Windows® XP or Windows Vista.

To operate correctly under Windows XP, Version 3.5 of Microsoft .NET must be installed. To run the software on a Windows 7 PC, XP emulation mode must be used (using Virtual PC).

## REGISTER SUMMARY

Table 9. Register Functions

Register	Function
Register 0	Integer divide control (for the PLL)
Register 1	Modulus divide control (for the PLL)
Register 2	Fractional divide control (for the PLL)
Register 3	$\Sigma\Delta$ modulator dither control
Register 4	PLL charge pump, PFD, and reference path control
Register 5	LO path and modulator control
Register 6	VCO control and VCO enable
Register 7	External VCO enable

## REGISTER DESCRIPTION

### REGISTER 0—INTEGER DIVIDE CONTROL

(DEFAULT: 0x0001C0)

With Register 0, Bits[2:0] set to 000, the on-chip integer divide control register is programmed as shown in Figure 41.

#### Divide Mode

Divide mode determines whether fractional mode or integer mode is used. In integer mode, the RF VCO output frequency ( $f_{VCO}$ ) is calculated by

$$f_{VCO} = 2 \times f_{PFD} \times (INT) \quad (1)$$

where:

$f_{VCO}$  is the output frequency of the internal VCO.

$f_{PFD}$  is the frequency of operation of the phase-frequency detector.

$INT$  is the integer divide ratio value (21 to 123 in integer mode).

#### Integer Divide Ratio

The integer divide ratio bits are used to set the integer value in Equation 2. The INT, FRAC, and MOD values make it possible to generate output frequencies that are spaced by fractions of the PFD frequency. The VCO frequency ( $f_{VCO}$ ) equation is

$$f_{VCO} = 2 \times f_{PFD} \times (INT + (FRAC/MOD)) \quad (2)$$

where:

$INT$  is the preset integer divide ratio value (24 to 119 in fractional mode).

$MOD$  is the preset fractional modulus (1 to 2047).

$FRAC$  is the preset fractional divider ratio value (0 to  $MOD - 1$ ).

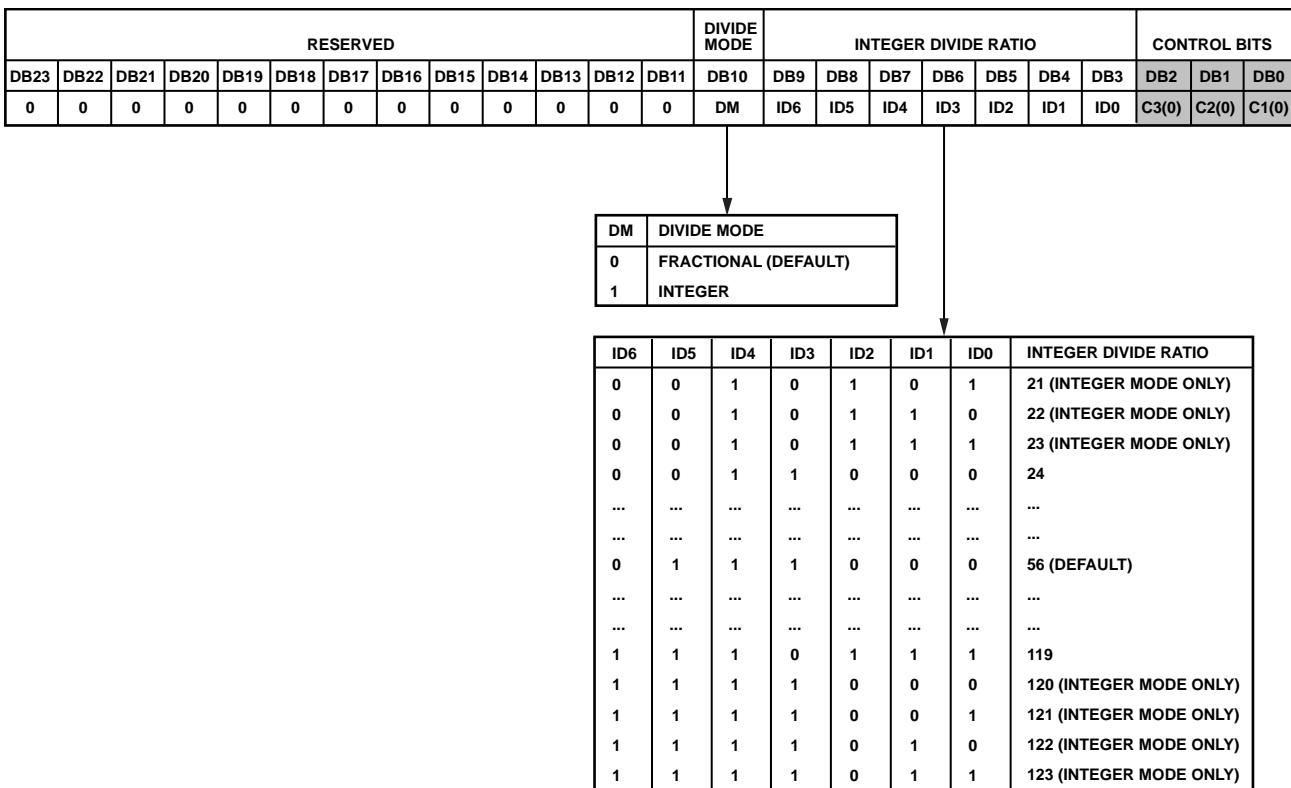


Figure 41. Register 0—Integer Divide Control Register Map

## REGISTER 1—MODULUS DIVIDE CONTROL (DEFAULT: 0x003001)

With Register 1, Bits[2:0] set to 001, the on-chip modulus divide control register is programmed as shown in Figure 42.

### **Modulus Value**

The modulus value is the preset fractional modulus ranging from 1 to 2047.

## REGISTER 2—FRACTIONAL DIVIDE CONTROL (DEFAULT: 0x001802)

With Register 2, Bits[2:0] set to 010, the on-chip fractional divide control register is programmed as shown in Figure 43.

### **Fractional Value**

The FRAC value is the preset fractional modulus ranging from 0 to <MDR.

RESERVED												MODULUS VALUE												CONTROL BITS		
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	C3(0)	C2(0)	C1(1)
0	0	0	0	0	0	0	0	0	0	MD10	MD9	MD8	MD7	MD6	MD5	MD4	MD3	MD2	MD1	MD0	C3(0)	C2(0)	C1(1)			

MD10	MD9	MD8	MD7	MD6	MD5	MD4	MD3	MD2	MD1	MD0	MODULUS VALUE
0	0	0	0	0	0	0	0	0	0	1	1
0	0	0	0	0	0	0	0	0	1	0	2
...	...	...	...	...	...	...	...	...	...	...	...
...	...	...	...	...	...	...	...	...	...	...	...
1	1	0	0	0	0	0	0	0	0	0	1536 (DEFAULT)
...	...	...	...	...	...	...	...	...	...	...	...
...	...	...	...	...	...	...	...	...	...	...	...
1	1	1	1	1	1	1	1	1	1	1	2047

Figure 42. Register 1—Modulus Divide Control Register Map

08570-016

RESERVED												FRACTIONAL VALUE												CONTROL BITS		
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	C3(0)	C2(1)	C1(0)
0	0	0	0	0	0	0	0	0	0	FD10	FD9	FD8	FD7	FD6	FD5	FD4	FD3	FD2	FD1	FD0	C3(0)	C2(1)	C1(0)			

FD10	FD9	FD8	FD7	FD6	FD5	FD4	FD3	FD2	FD1	FD0	FRACTIONAL VALUE
0	0	0	0	0	0	0	0	0	0	0	0
0	0	0	0	0	0	0	0	0	1	1	1
...	...	...	...	...	...	...	...	...	...	...	...
...	...	...	...	...	...	...	...	...	...	...	...
0	1	1	0	0	0	0	0	0	0	0	768 (DEFAULT)
...	...	...	...	...	...	...	...	...	...	...	...
...	...	...	...	...	...	...	...	...	...	...	<MDR

Figure 43. Register 2—Fractional Divide Control Register Map

08570-016

**REGISTER 3—Σ-Δ MODULATOR DITHER CONTROL  
(DEFAULT: 0x10000B)**

With Register 3, Bits[2:0] set to 011, the on-chip Σ-Δ modulator dither control register is programmed as shown in Figure 44. The recommended and default setting for dither enable is enabled (1).

The default value of the dither magnitude (15) should be set to a recommended value of 1.

The dither restart value can be programmed from 0 to  $2^{17} - 1$ , though a value of 1 is typically recommended.

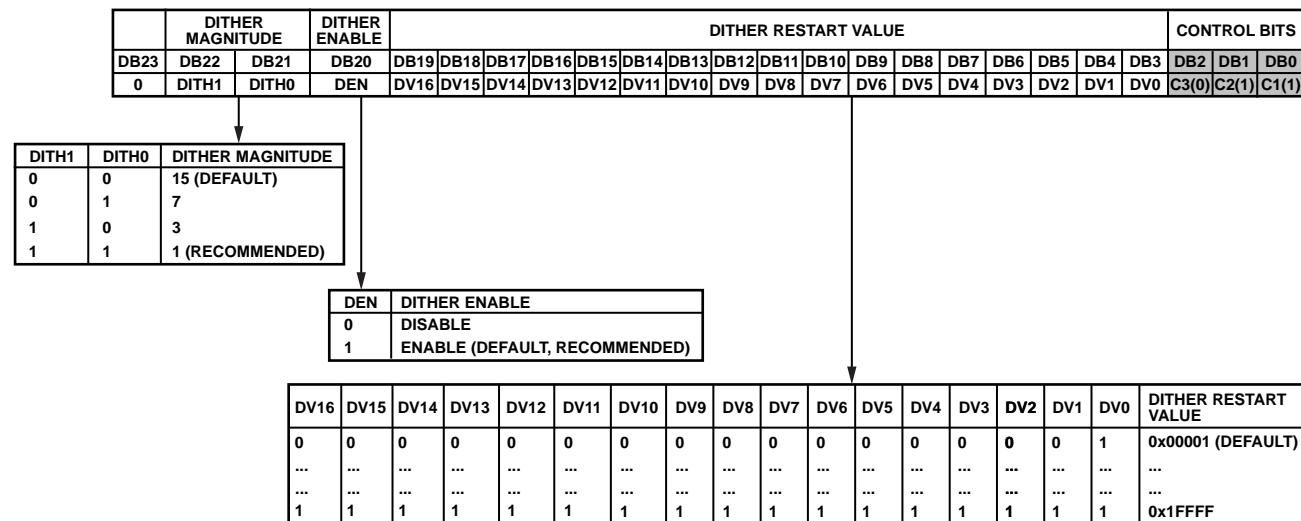


Figure 44. Register 3—Σ-Δ Modulator Dither Control Register Map

08570-07

## REGISTER 4—PLL CHARGE PUMP, PFD, AND REFERENCE PATH CONTROL (DEFAULT: 0x0AA7E4)

With Register 4, Bits[2:0] set to 100, the on-chip charge pump, PFD, and reference path control register is programmed as shown in Figure 45.

### CP Current

The nominal charge pump current can be set to 250  $\mu$ A, 500  $\mu$ A, 750  $\mu$ A, or 1000  $\mu$ A using DB10 and DB11 of Register 4 and by setting DB18 to 0 (CP reference source).

In this mode, no external RSET is required. If DB18 is set to 1, the four nominal charge pump currents ( $I_{NOMINAL}$ ) can be externally tweaked according to the following equation:

$$R_{SET} = \left( \frac{217.4 \times I_{CP}}{I_{NOMINAL}} \right) - 37.8\Omega \quad (3)$$

where  $I_{CP}$  is the base charge pump current in microamps.

The PFD phase offset multiplier ( $\theta_{PFD,OFS}$ ), which is set by Bits[16:12] of Register 4, causes the PLL to lock with a nominally fixed phase offset between the PFD reference signal and the divided-down VCO signal. This phase offset is used to linearize the PFD-to-CP transfer function and can improve

fractional spurs. The magnitude of the phase offset is determined by the following equation:

$$|\Delta\Phi|(deg) = 22.5 \frac{\theta_{PFD,OFS}}{I_{CP,MULT}} \quad (4)$$

The default value of the phase offset multiplier ( $10 \times 22.5^\circ$ ) should be set to a recommended value of  $6 \times 22.5^\circ$ .

This phase offset can be either positive or negative depending on the value of DB17 in Register 4.

The reference frequency applied to the PFD can be manipulated using the internal reference path source. The external reference frequency applied can be internally scaled in frequency by  $2\times$ ,  $1\times$ ,  $0.5\times$ , or  $0.25\times$ . This allows a broader range of reference frequency selections while keeping the reference frequency applied to the PFD within an acceptable range.

The device also has a MUXOUT pin that can be programmed to output a selection of several internal signals. The default mode is to provide a lock-detect output to allow the user to verify when the PLL has locked to the target frequency. In addition, several other internal signals can be passed to the MUXOUT pin as described in Figure 35.

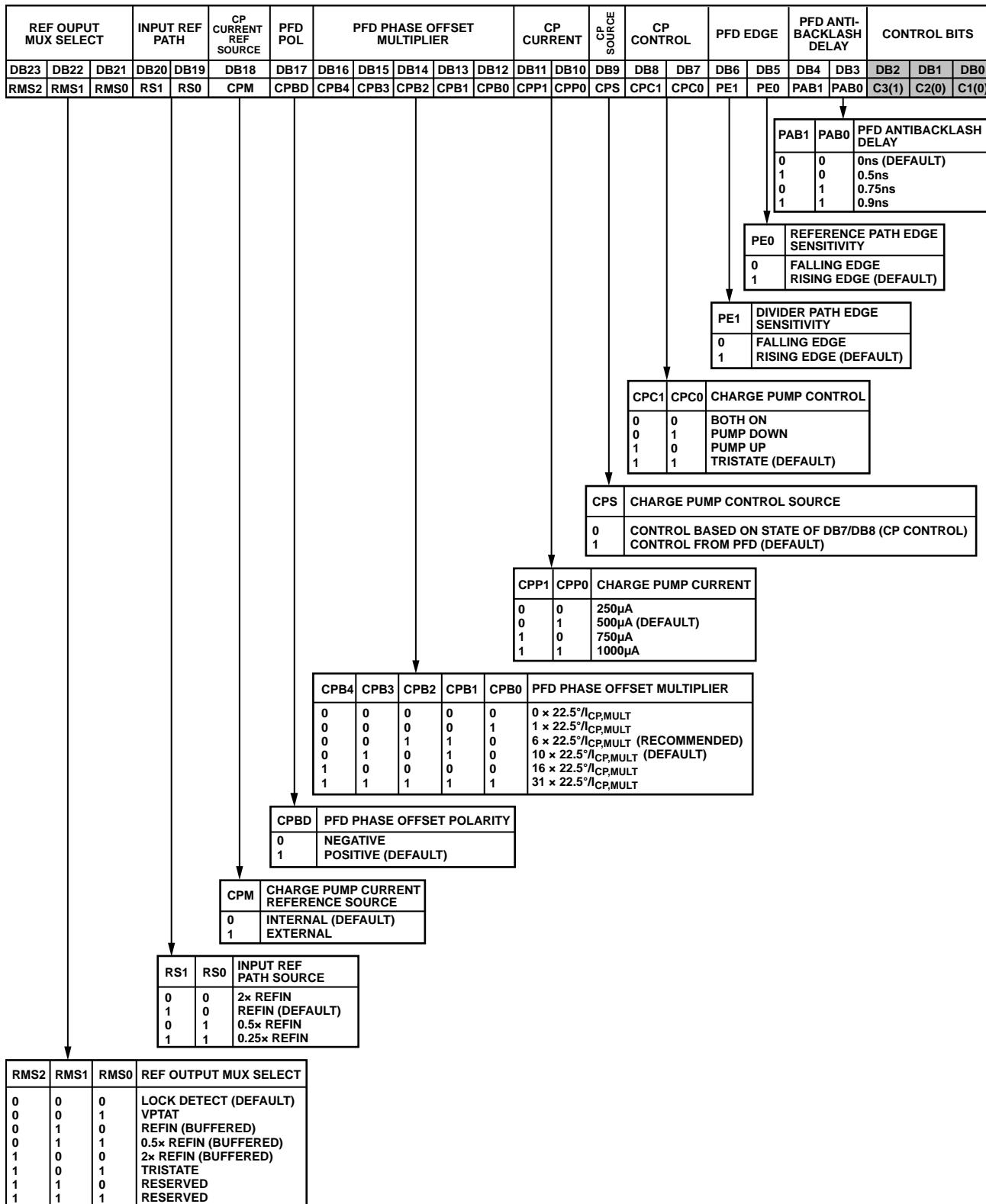


Figure 45. Register 4—PLL Charge Pump, PFD, and Reference Path Control Register Map

## REGISTER 5—LO PATH AND MODULATOR CONTROL (DEFAULT: 0X0000D5)

With Register 5, Bits[2:0] set to 101, the LO path and modulator control register is programmed as shown in Figure 46.

The modulator output or the complete modulator can be disabled using the modulator bias enable and modulator output enable addresses of Register 5.

The LO port (LOP and LON pins) can be used to apply an external  $2\times$  LO (that is, bypass internal PLL) to the IQ modulator. A differential LO drive of 0 dBm is recommended.

The LO port can also be used as an output where a  $2\times$  LO or  $1\times$  LO can be brought out and used to drive another mixer. The nominal output power provided at the LO port is 3 dBm. The mode of operation of the LO port is determined by the status of the LOSEL pin (3.3 V logic) along with the settings in a number of internal registers (see Table 10).

Table 10. LO Port Configuration<sup>1,2</sup>

LON/LOP Function	LOSEL	Register 5, Bit DB5 (LDIV)	Register 5, Bit DB4 (LXL)	Register 5, Bit DB3 (LDRV)
Input ( $2\times$ LO)	0	X	1	0
Output (Disabled)	0	X	0	0
Output ( $1\times$ LO)	0	0	0	1
Output ( $1\times$ LO)	1	0	0	0
Output ( $1\times$ LO)	1	0	0	1
Output ( $2\times$ LO)	0	1	0	1
Output ( $2\times$ LO)	1	1	0	0
Output ( $2\times$ LO)	1	1	0	1

<sup>1</sup> X = don't care.

<sup>2</sup> LOSEL should not be left floating.

The internal VCO of the device can also be bypassed. In this case, the charge pump output drives an external VCO through the loop filter. The loop is completed by routing the VCO into the device through the LO port.

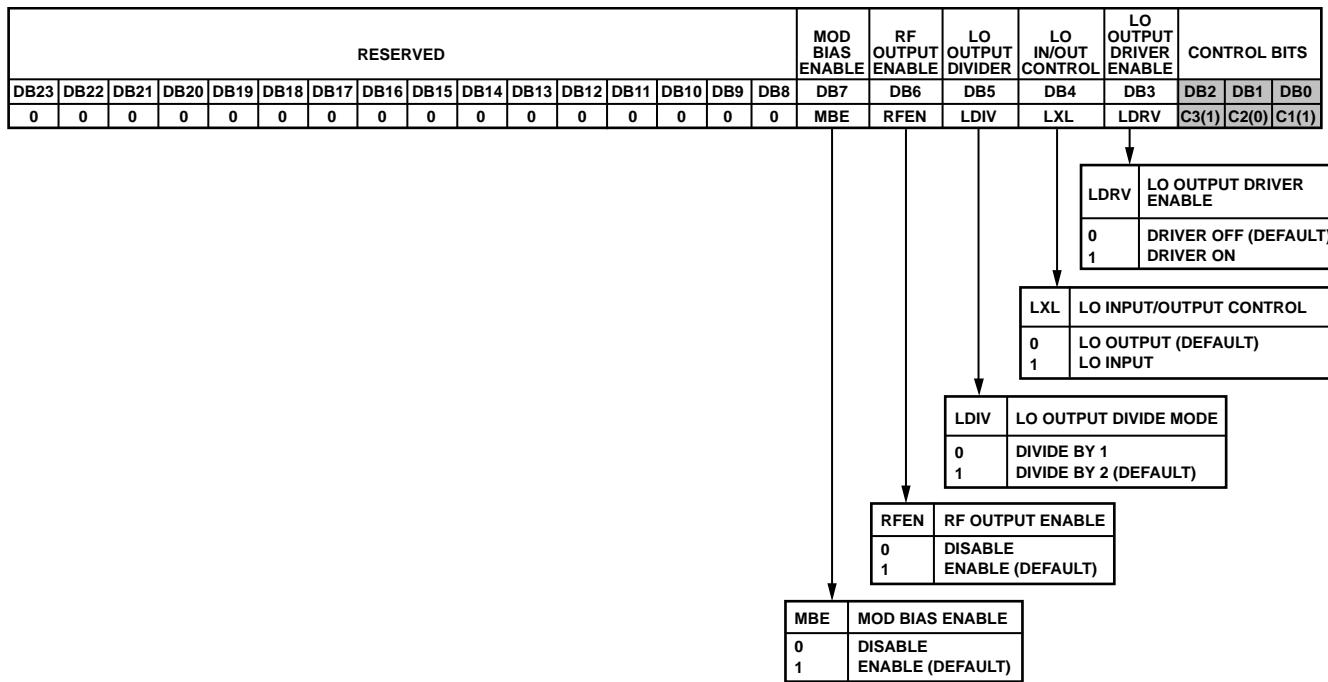


Figure 46. Register 5—LO Path and Modulator Control Register Map

## REGISTER 6—VCO CONTROL AND VCO ENABLE (DEFAULT: 0X1E2106)

With Register 6, Bits[2:0] set to 110, the VCO control and enable register is programmed as shown in Figure 47.

The VCO tuning band is normally selected automatically by the band calibration algorithm, although the user can directly select the VCO band using Register 6.

The VCO BS SRC bit (DB9) determines whether the result of the calibration algorithm is used to select the VCO band or if the band selected is based on the value in VCO band select (DB8 to DB3).

The VCO amplitude can be controlled through Register 6. The VCO amplitude setting can be controlled between 0 and 63. The default value of 8 should be set to a recommended value of 63.

The internal VCOs can be disabled using Register 6.

The internal charge pump can be disabled through Register 6. By default, the charge pump is enabled.

To turn off the PLL (for example, if the ADRF6703 is being driven by an external LO), set Register 6, Bits[20:17] to zero.

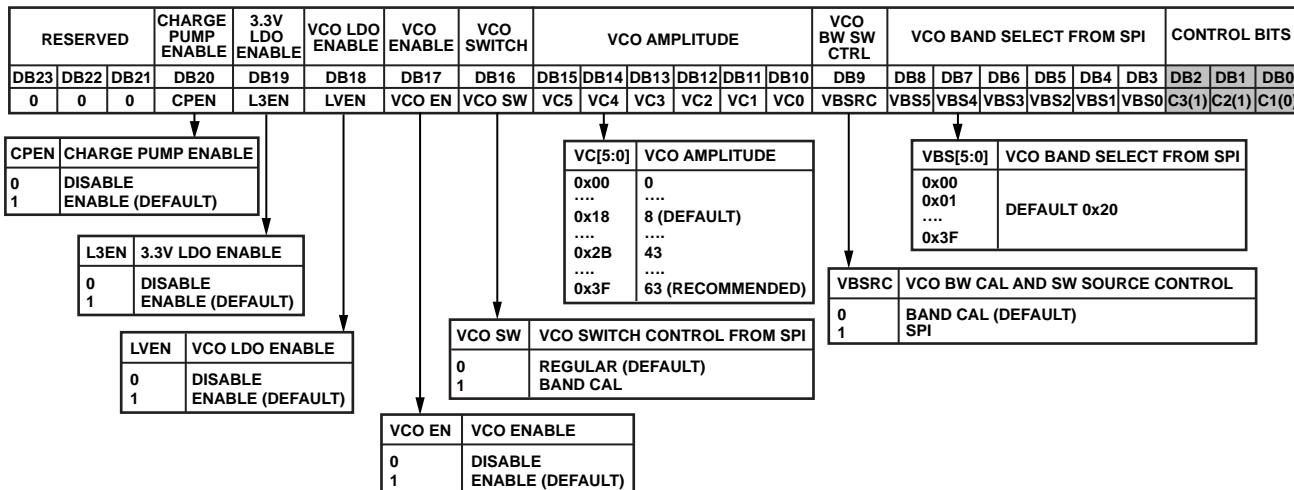


Figure 47. Register 6—VCO Control and VCO Enable Register Map

RES	EXTERNAL VCO ENABLE	RESERVED																CONTROL BITS					
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	XVCO	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	C3(1)	C2(1)	C1(1)
XVCO   EXTERNAL VCO ENABLE																							
0   INTERNAL VCO (DEFAULT) 1   EXTERNAL VCO																							

Figure 48. Register 7—External VCO Enable Register Map

08570-020  
08570-021

## CHARACTERIZATION SETUPS

Figure 49 and Figure 50 show characterization bench setups used to characterize the ADRF6703. The setup shown in Figure 49 was used to do most of the testing. An automated VEE program was used to control equipment over the IEEE bus. The setup was used to measure SSB, OIP2, OIP3, OP1dB, LO, and USB NULL.

For phase noise and reference spurs measurements, see the phase noise setup on Figure 50. Phase noise was measured on LO and modulator output.

**ADRF670x TEST RACK ASSEMBLY (INTERNAL VCO CONFIGURATION)  
ALL INSTRUMENTS ARE CONNECTED IN DAISY CHAIN  
FASHION VIA GPIB CABLE UNLESS OTHERWISE NOTED.**

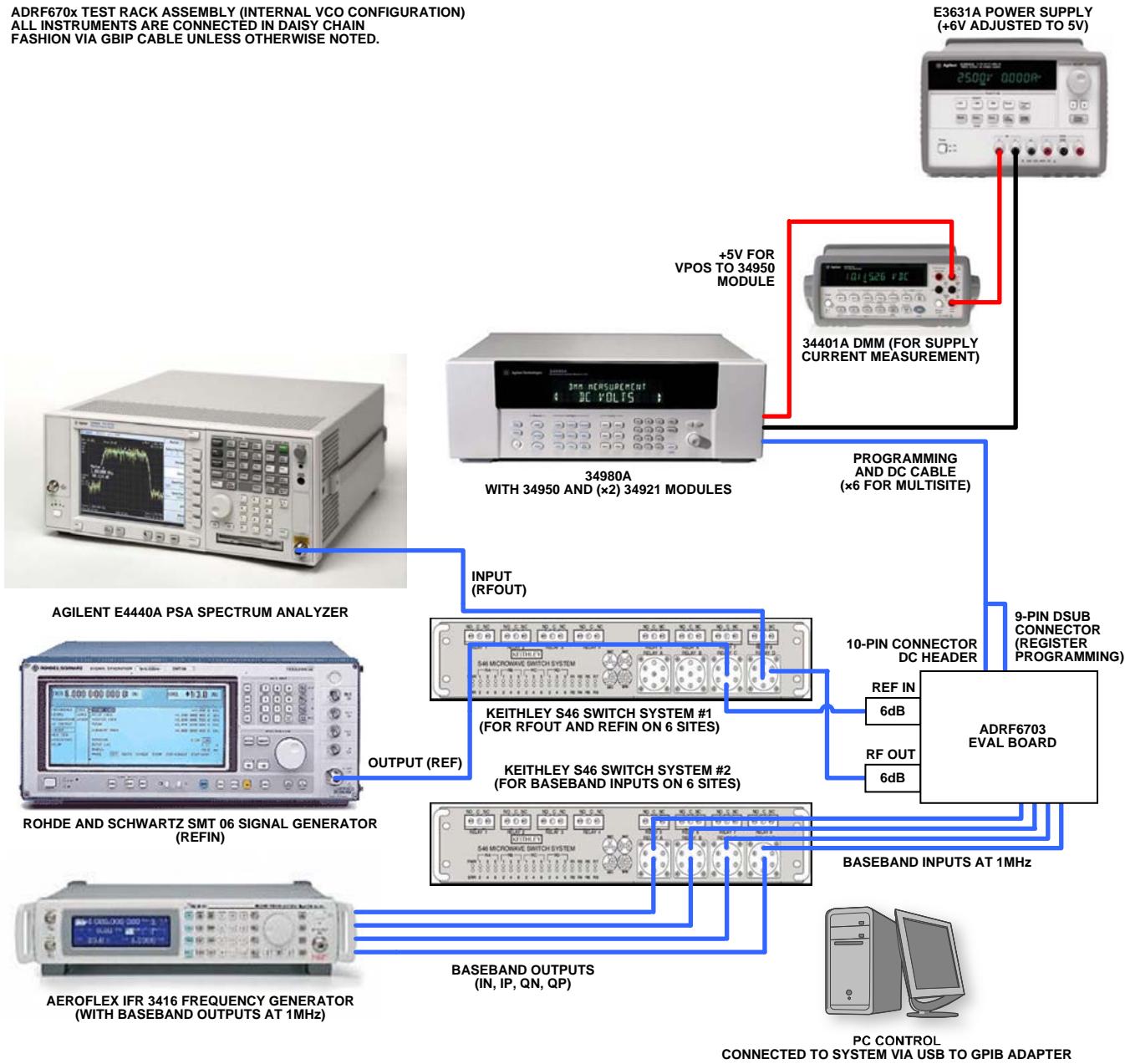


Figure 49. General Characterization Setup

ADRF670x PHASE NOISE STAND SETUP  
ALL INSTRUMENTS ARE CONNECTED IN DAISY CHAIN FASHION  
VIA GPIB CABLE UNLESS OTHERWISE NOTED.

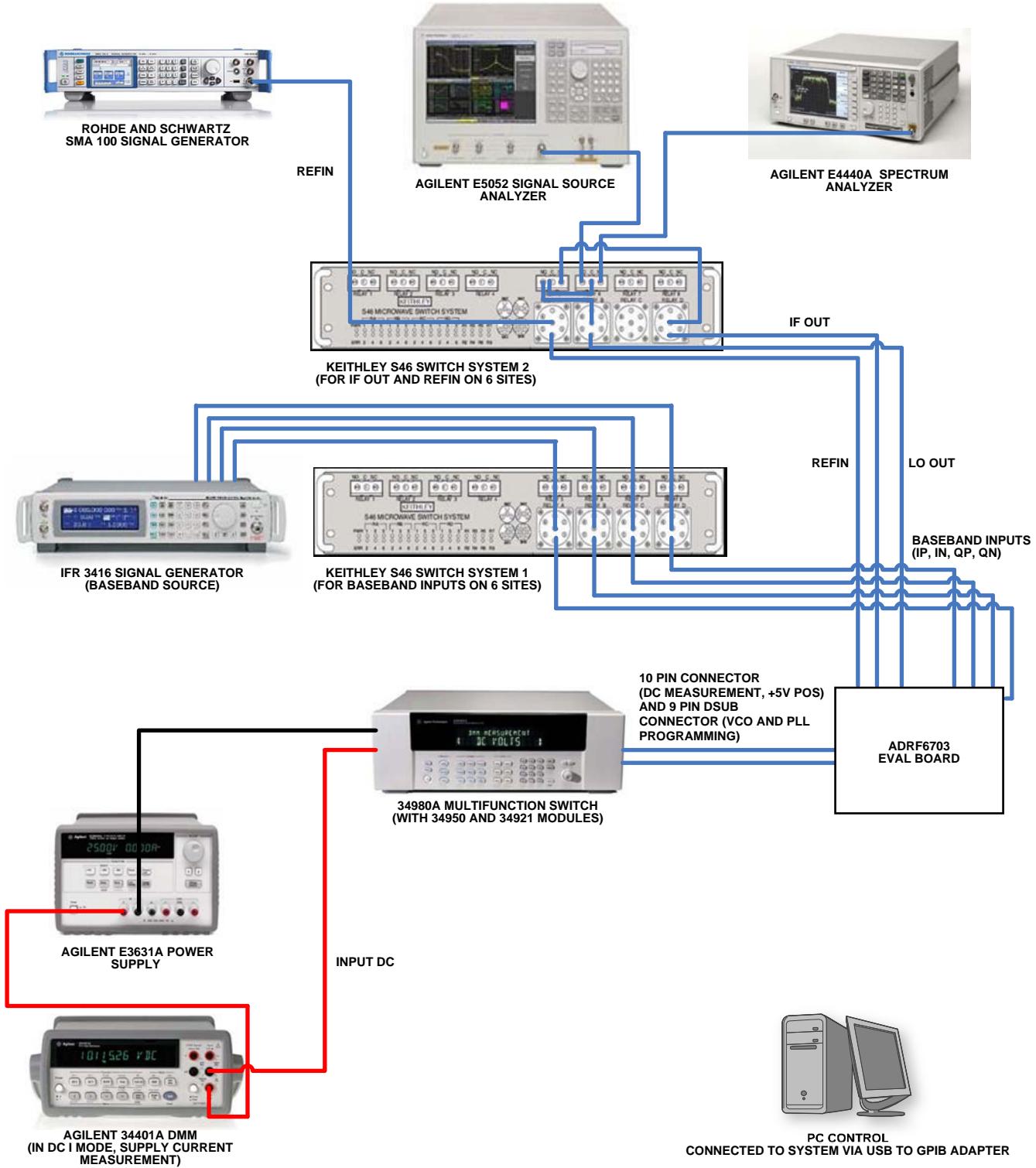


Figure 50. Characterization Setup for Phase Noise and Reference Spur Measurements

## EVALUATION BOARD

Figure 52 shows the schematic of the device's RoHS-compliant evaluation board. This board was designed using Rogers 4350 material to minimize losses at high frequencies. FR4 material would also be adequate but with the slightly higher trace loss of this material.

Whereas the on-board USB interface circuitry of the evaluation board is powered directly from the PC, the main section of the evaluation board requires a separate 5 V power supply.

The evaluation board is designed to operate using the internal VCO (default configuration) of the device or with an external VCO. To use an external VCO, R62 and R12 should be removed. 0 Ω resistors should be placed in R63 and R11. A side-launched SMA connector (Johnson 142-0701-851) must be soldered to the pad labeled VTUNE. The input of the external VCO should be connected to the VTUNE SMA connector and a portion of the VCO's output should be connected to the EXT LO SMA connector. In addition to these hardware changes, internal register settings must also be changed (as detailed in the Register Description section) to enable operation with an external VCO.

Additional configuration options for the evaluation board are described in Table 11.

The serial port of the [ADRF6703](#) can be programmed from a PC's USB port (a USB cable is provided with the evaluation board). The on-board USB interface circuitry can if desired be bypassed by removing the 0 Ω resistors, R15, R17, and R18 (see Figure 52) and driving the [ADRF6703](#) serial interface through the P3 4-pin header (P3 must be first installed, Samtec TSW-104-08-G-S).

## EVALUATION BOARD CONTROL SOFTWARE

USB-based programming software is available to download from the [ADRF6703](#) product page at [www.analog.com](http://www.analog.com) (Evaluation Board Software Rev 6.1.0). To install the software, download and extract the zip file. Then run the following installation file: **ADRF6X0X\_6p1p0\_customer\_installer.exe**.

To operate correctly under Windows XP, Version 3.5 of Microsoft .NET must be installed. To run the software on a Windows 7 PC, XP emulation mode must be used (using Virtual PC).

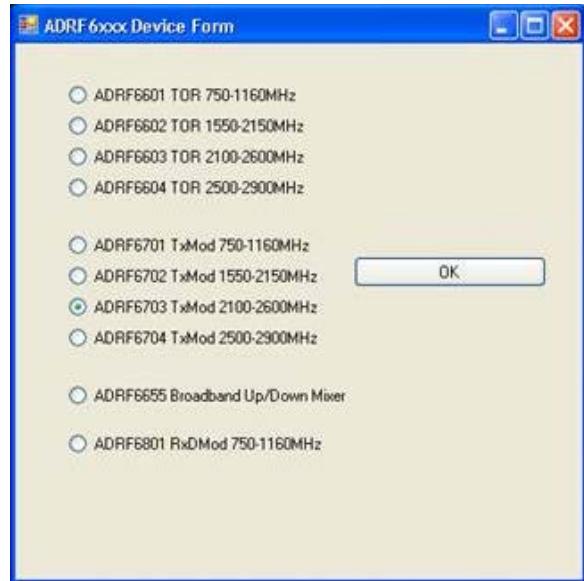
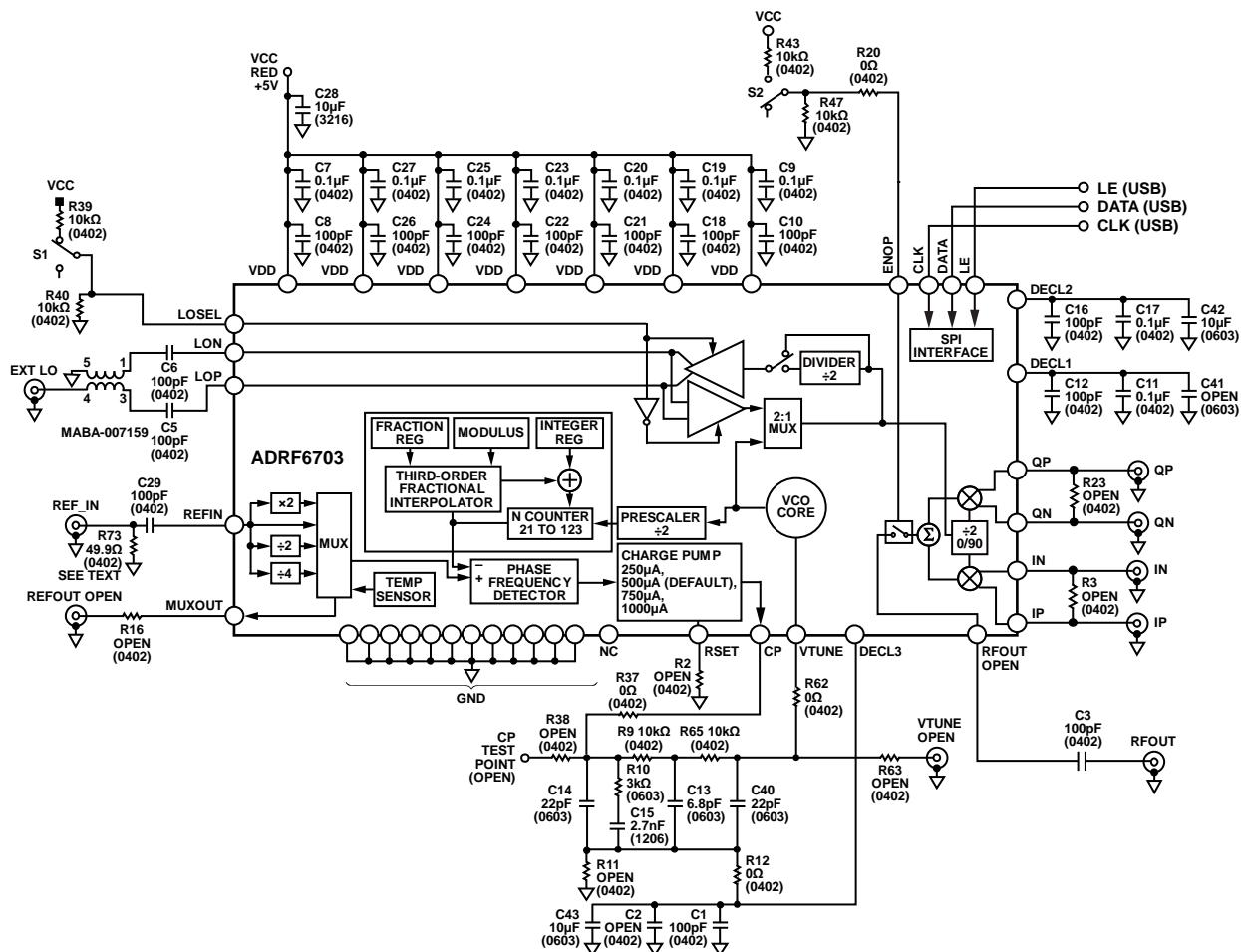


Figure 51. Control Software Opening Menu

Figure 51 shows the opening window of the software where the user selects the device being programmed. Figure 55 shows a screen shot of the control software's main controls with the default settings displayed. The text box in the bottom left corner provides an immediate indication of whether the software is successfully communicating with the evaluation board. If the evaluation board is connected to the PC via the USB cable provided and the software is successfully communicating with the on-board USB circuitry, this text box shows the following message: **ADRF6X0X eval board connected**.



NOTES  
1. NC = NO CONNECT. DO NOT CONNECT TO THIS PIN.

Figure 52. Evaluation Board Schematic (Loop Filter Set to 130 kHz)

08570-027

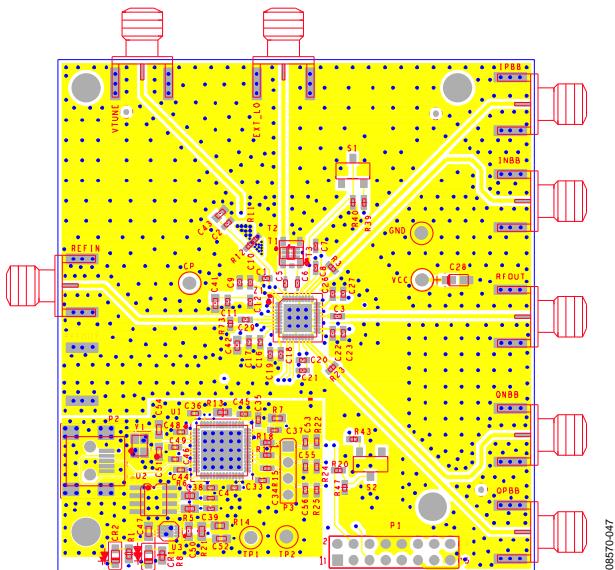


Figure 53. Evaluation Board Top Layer

08570-047

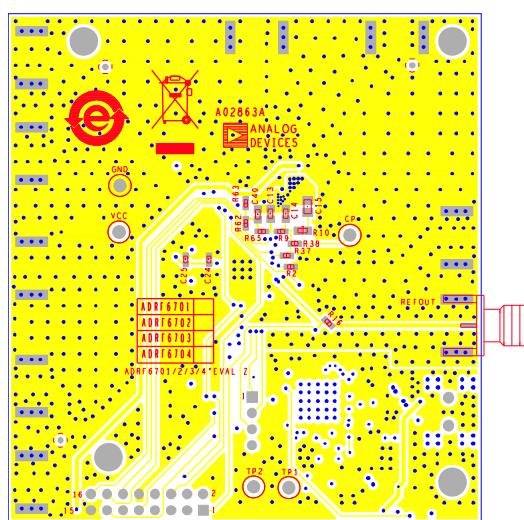
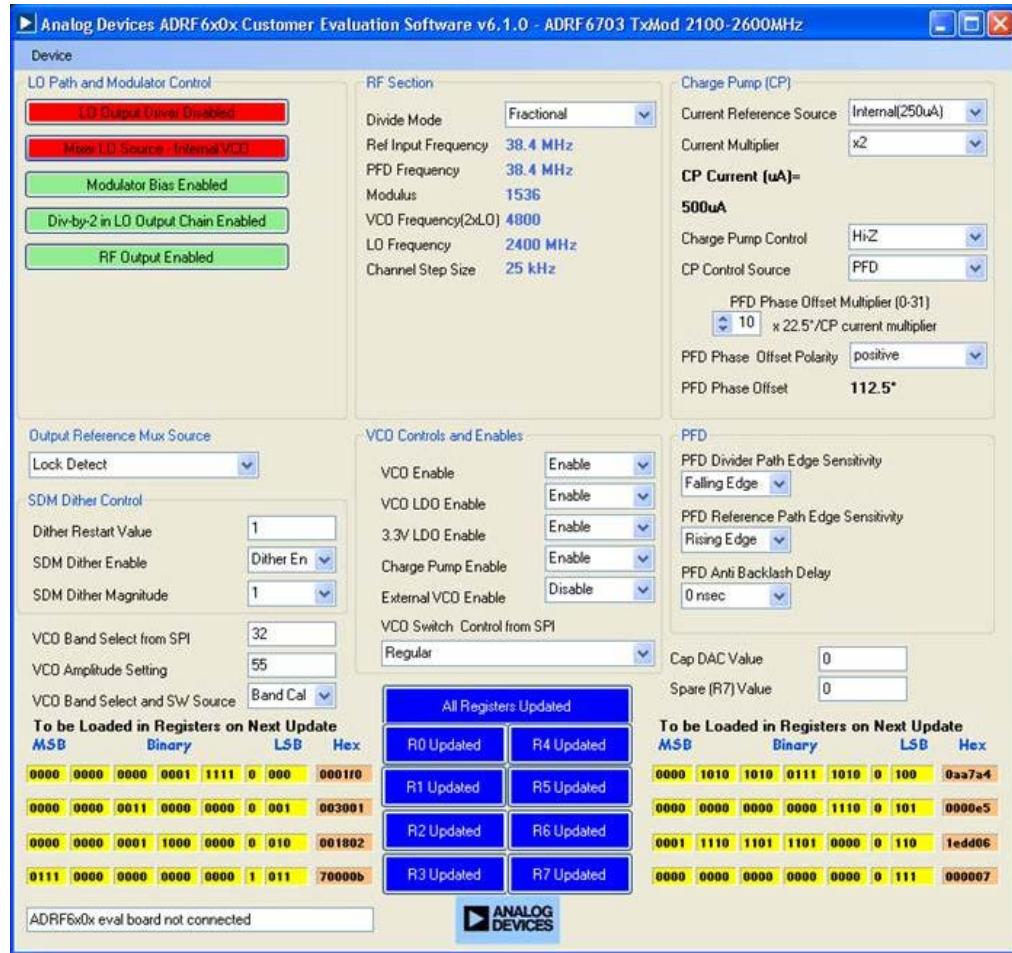


Figure 54. Evaluation Board Bottom Layer

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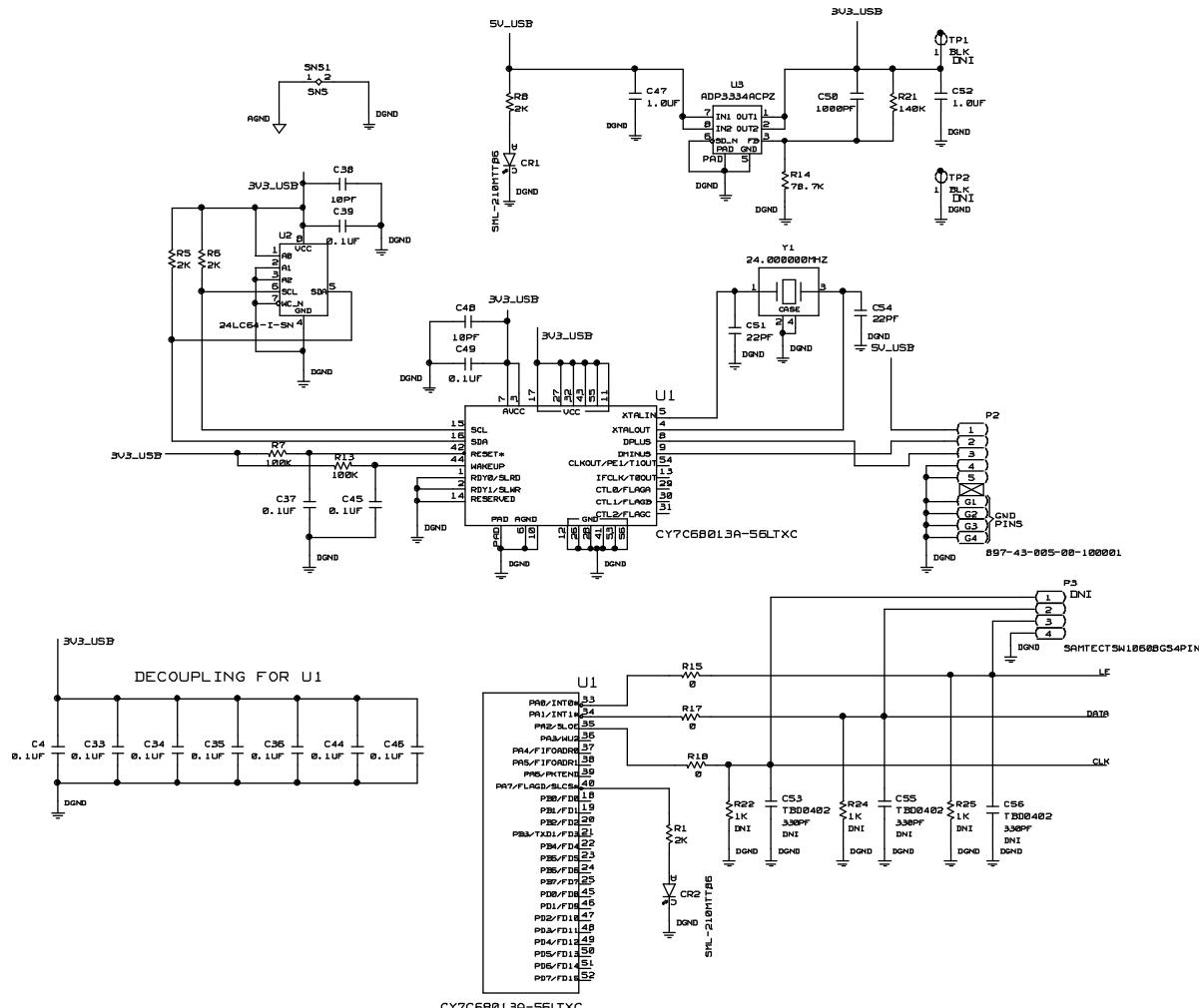
Table 11. Evaluation Board Configuration Options

Component	Description	Default Condition/Option Settings
S1, R39, R40	LO select. Switch and resistors to ground LOSEL pin. The LOSEL pin setting in combination with internal register settings, determines whether the LOP/LON pins function as inputs or outputs. With the LOSEL pin grounded, register settings can set the LOP/LON pins to be inputs or outputs.	
EXT LO, T3	LO input/output. An external 1x LO or 2x LO can be applied to this single-ended input connector. Alternatively, the internal 1x or 2x LO can be brought out on this pin. The differential LO signal on LOP and LON is converted to a single-ended signal using a broadband 1:1 balun (Macom MABA-007159, 4.5 MHz to 3000 MHz frequency range). The balun footprint on the evaluation board is also designed to accommodate Johanson baluns: 3600BL14M050 (1:1, 3.3 GHz to 3.9 GHz) and 3700BL15B050E (1:1, 3.4 GHz to 4 GHz).	T3 = Macom MABA-007159 EXT LO SMA connector = installed
REFIN SMA Connector, R73	Reference input. The input reference frequency for the PLL is applied to this connector. Input resistance is set by R73 (49.9 Ω).	
REFOUT SMA Connector, R16	Multiplexer output. The REFOUT connector connects directly to the device's MUXOUT pin. The on-board multiplexer can be programmed to bring out the following signals: REFIN, 2x REFIN, REFIN/2, REFIN/4, Temperature sensor output voltage (VPTAT), Lock detect indicator.	F <sub>REFIN</sub> = 153.6 MHz R73 = 49.9 Ω REFOUT SMA connector = open R16 = open
CP Test Point, R38	Charge pump test point. The unfiltered charge pump signal can be probed at this test point. Note that this pin should not be probed during critical measurements such as phase noise.	CP = open R38 = open
C13, C14, C15, C40R9, R10, R37, R65 R11, R12, R62, R63, VTUNE SMA Connector	Loop filter. Loop filter components.  Internal vs. external VCO. When the internal VCO is enabled, the loop filter components connect directly to the VTUNE pin (Pin 39) by installing a 0 Ω resistor in R62. In addition, the loop filter components should be returned to Pin 40 (DECL3) by installing a 0 Ω resistor in R12.  To use an external VCO, R62 should be left open. A 0 Ω resistor should be installed in R63, and the voltage input of the VCO should be connected to the VTUNE SMA connector. The output of the VCO is brought back into the PLL via the LO IN/OUT SMA connector. In addition, the loop filter components should be returned to ground by installing a 0 Ω resistor in R11.  Loop filter return.	See Table 8 R12 = 0 Ω (0402) R11 = open (0402) R62 = 0 Ω (0402) R63 = open (0402) VTUNE = open
R2 R23, R3	RSET. This pin is unused and should be left open.  Baseband input termination. Termination resistors for the baseband filter of the DAC can be placed on R23 and R3. In addition to terminating the baseband filters, these resistors also scale down the baseband voltage from the DAC without changing the bias level. These resistors are generally set in the 100 Ω to 300 Ω range.	R2 = open (0402) R3 = R23 = open (0402)
P3 4-Pin Header, R15, R17, R18	USB circuitry bypass. The USB circuitry can be bypassed, allowing for the serial port of the ADRF6703 to be driven directly. P3 (Samtec TSW-104-08-G-S) must be installed, and 0 Ω resistors (R15, R17 and R18) must be removed.	P3 = open R15, R17, R18 = 0 Ω (0402)



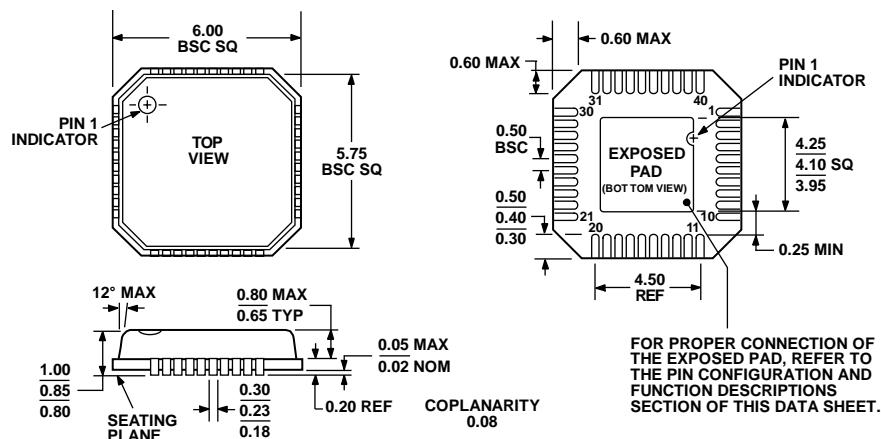
08570-136

Figure 55. Main Controls of the Evaluation Board Control Software



*Figure 56. USB Interface Circuitry on the Customer Evaluation Board*

# OUTLINE DIMENSIONS



**COMPLIANT TO JEDEC STANDARDS MO-220-VJJD-2**

*Figure 57. 40-Lead Lead Frame Chip Scale Package [LFCSP\_VQ]  
 6 mm × 6 mm Body, Very Thin Quad  
 (CP-40-1)*

*Dimensions shown in millimeters*

172108-A

## **ORDERING GUIDE**

<b>Model<sup>1</sup></b>	<b>Temperature Range (°C)</b>	<b>Package Description</b>	<b>Package Option</b>
ADRF6703ACPZ-R7	–40°C to +85°C	40-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-40-1
ADRF6703-EVALZ		Evaluation Board	

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**



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Электрон  
Связь**

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